

## **Datasheet**

DS000504

# **AS7341**

# 11-Channel Spectral Sensor Frontend

v2-00 • 2019-Apr-16



# **Content Guide**

| 1                               | General Description  | 3              |
|---------------------------------|--|----------------|
| 1.1<br>1.2<br>1.3               | Key Benefits & Features<br>Applications<br>Block Diagram     | 4              |
| 2                               | Ordering Information   | 5              |
| 3                               | Pin Assignment   | 6              |
| 3.1<br>3.2                      | Pin DiagramPin Description                                   |                |
| 4                               | Absolute Maximum Ratings                                     | 7              |
| 5                               | Electrical Characteristics                                   | 8              |
| 6                               | Optical Characteristics                                      | 9              |
| 7                               | Typical Operating Characteristics                            | 15             |
| 8                               | Functional Description                                       | 16             |
| 8.1<br>8.2<br>8.3<br>8.4<br>8.5 | Channel ArchitectureSensor ArrayGPIO/INTSMUXIntegration Mode | 18<br>18<br>18 |
| 9                               | I <sup>2</sup> C Interface                                   | 21             |

| 9.1  | I <sup>2</sup> C Address 21         |   |
|------|-------------------------------------|---|
| 9.2  | I <sup>2</sup> C Write Transaction  |   |
| 9.3  | I <sup>2</sup> C Read Transaction   |   |
| 9.4  | Timing Characteristics 22           |   |
| 9.5  | Timing Diagrams                     | , |
| 10   | Register Description24              |   |
| 10.1 | Register Overview24                 |   |
| 10.2 | Detailed Register Description 26    |   |
| 11   | Application Information 58          | , |
| 11.1 | Schematic 58                        | 6 |
| 11.2 | PCB Pad Layout59                    |   |
| 11.3 | Application Optical Requirements 60 | ) |
| 12   | Package Drawings & Markings 61      |   |
| 13   | Tape & Reel Information 62          | , |
| 14   | Soldering & Storage Information 64  |   |
| 14.1 | Storage Information 65              | ) |
| 15   | Revision Information 66             | ) |
| 16   | Legal Information 67                | , |
|      |                                     |   |



# 1 General Description

AS7341 is an 11-channel spectrometer for spectral identification and color matching applications used in mobile devices. The spectral response is defined in the wavelengths from approximately 350nm to 1000nm. 6 channels can be processed in parallel by independent ADCs while the other channels are accessible via a multiplexer. 8 optical channels cover the visible spectrum, one channel can be used to measure near infra-red light and one channel is a photo diode without filter ("clear"). The device also integrates a dedicated channel to detect 50Hz or 60Hz ambient light flicker. The flicker detection engine can also buffer data for calculating other flicker frequencies externally. The NIR channel in combination with the other VIS channel may provide information of surrounding ambient light conditions (light source detection). The device can also be synchronized to external signals via pin GPIO.

AS7341 integrates filters into standard CMOS silicon via Nano-optic deposited interference filter technology and its package provides a built in aperture to control the light entering the sensor array. Control and Spectral data access is implemented through a serial I<sup>2</sup>C interface. The device is available in an ultra-low profile package with dimensions of 3.1mm x 2mm x 1mm.

## 1.1 Key Benefits & Features

The benefits and features of AS7341, 11-Channel Spectral Sensor Frontend, are listed below:

Figure 1: Added Value of Using AS7341

| Benefits  | Features  |
|---|---|
| Color matching and skin tone measurement in mobile phones   | 8 optical channels distributed over the visible spectral range + clear and NIR channel to accurately measure and match colors in mobile phones                              |
| Low power consumption and minimum I <sup>2</sup> C traffic  | <ul><li>1.8VDD operation</li><li>Configurable sleep mode</li><li>Interrupt-driven device</li></ul>  |
| Integrated ambient light flicker detection on chip and light source detection through NIR channel | <ul> <li>Dedicated channel</li> <li>Independently configurable timing and gain</li> <li>Automatic gain adjustment</li> <li>50Hz and 60Hz flicker detection flags</li> </ul> |
| Electronic shutter/external trigger functionality   | GPIO can be used as external trigger input  |
| External photodiodes to expand detection range  | GPIO can be used as input for external InGaAs PDs for MIR range.  |



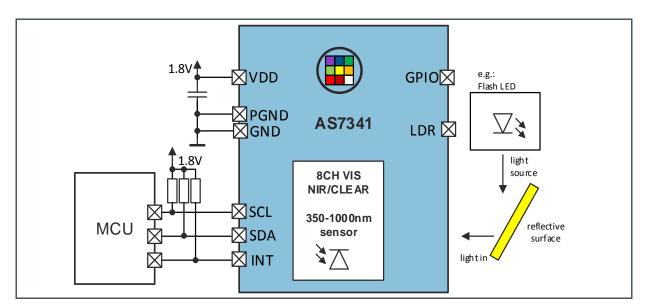
## 1.2 Applications

- Reflective object color sensor in mobile phones
- Color management for displays
- Ambient light flicker detection for camera assist (flicker detection)

## 1.3 Block Diagram

The functional blocks of this device are shown below:

Figure 2: Functional Blocks of AS7341





# 2 Ordering Information

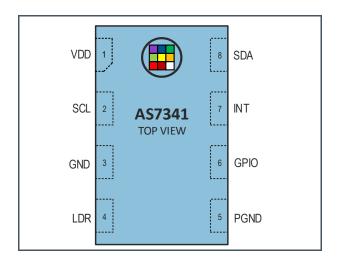
| Ordering Code | Package | Delivery Form       | Delivery Quantity |
|---------------|---------|---------------------|-------------------|
| AS7341-DLGT   | OLGA-8  | Tape & Reel 13-inch | 5000 pcs/reel     |
| AS7341-DLGM   | OLGA-8  | Tape & Reel 7-inch  | 500 pcs/reel      |



# 3 Pin Assignment

## 3.1 Pin Diagram

Figure 3: Pin Assignment of AS7341 (TOP VIEW)



## 3.2 Pin Description

Figure 4: Pin Description of AS7341

| Pin Number | Pin Name | Pin Type <sup>(1)</sup> | Description   |
|------------|----------|-------------------------|---|
| 1          | VDD      | Р                       | Positive supply terminal  |
| 2          | SCL      | DI                      | Serial interface clock signal line for I <sup>2</sup> C interface |
| 3          | GND      | Р                       | Ground. All voltages referenced to GND                            |
| 4          | LDR      | A_I/O                   | LED current sink input  |
| 5          | PGND     | Р                       | Ground. All voltages referenced to GND                            |
| 6          | GPIO     | DI                      | General purpose input/output                                      |
| 7          | INT      | DO_OD                   | Interrupt. Open drain output. Connect pull up resistor to 1.8V.   |
| 8          | SDA      | D_I/O                   | Serial interface data signal line for I <sup>2</sup> C interface  |

(1) Explanation of abbreviations:

DI Digital Input
D\_I/O Digital Input/Output
DO\_OD Digital Output, open drain

P Power pin A\_I/O Analog pin



# 4 Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "Operating Conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. All voltages with respect to GND/PGND. Device parameters are guaranteed at V<sub>DD</sub>=1.8V and T<sub>A</sub>=25°C unless otherwise noted.

Figure 5
Absolute Maximum Ratings of AS7341

| Symbol                             | Parameter                          | Min  | Max | Unit | Comments                            |
|------------------------------------|------------------------------------|------|-----|------|-------------------------------------|
| Electrical Pa                      | arameters                          |      |     |      |                                     |
| V <sub>DD</sub> / V <sub>GND</sub> | Supply Voltage to Ground           | -0.3 | 2.2 | V    | Applicable for pin VDD              |
| V <sub>ANA_MAX</sub>               | Analog Pins                        | -0.3 | 3.6 | V    | Applicable for pin LDR              |
| $V_{DIG\_MAX}$                     | Digital Pins                       | -0.3 | 3.6 | V    | Applicable for pins SCL,SDA and INT |
| I <sub>SCR</sub>                   | Input Current (latch-up immunity)  | ± 1  | 00  | mA   | JEDEC JESD78D Nov<br>2011           |
| lo                                 | Output Terminal Current            | -1   | 20  | mA   |                                     |
| Electrostation                     | c Discharge                        |      |     |      |                                     |
| ESD <sub>HBM</sub>                 | Electrostatic Discharge HBM        | ± 2  | 000 | V    | JS-001-2014                         |
| ESD <sub>CDM</sub>                 | Electrostatic Discharge CDM        | ± 5  | 500 | V    | JEDEC JESD22-C101F                  |
| Temperature                        | e Ranges and Storage Conditions    |      |     |      |                                     |
| T <sub>A</sub>                     | Operating Ambient Temperature      | -30  | 85  | °C   |                                     |
| T <sub>STRG</sub>                  | Storage Temperature Range          | -40  | 85  | °C   |                                     |
| T <sub>BODY</sub>                  | Package Body Temperature           |      | 260 | °C   | IPC/JEDEC J-STD-020 <sup>(1)</sup>  |
| RH <sub>NC</sub>                   | Relative Humidity (non-condensing) | 5    | 85  | %    |                                     |
| MSL                                | Moisture Sensitivity Level         | ;    | 3   |      | Maximum floor life time of 168h     |

<sup>(1)</sup> The reflow peak soldering temperature (body temperature) is specified according to IPC/JEDEC J-STD-020 "Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices." The lead finish for Pb-free leaded packages is "Matte Tin" (100% Sn)



## **5** Electrical Characteristics

All limits are guaranteed. The parameters with Min and Max values are guaranteed with production tests or SQC (Statistical Quality Control) methods. All voltages with respect to GND/PGND. Device parameters are guaranteed at VDD=1.8V and T<sub>A</sub>=25°C unless otherwise noted.

Figure 6: Electrical Characteristics of AS7341

| Symbol            | Parameter   | Conditions   | Min  | Тур | Max  | Unit |  |  |  |  |
|-------------------|---|--|------|-----|------|------|--|--|--|--|
| $V_{DD}$          | Supply Voltage  |  | 1.7  | 1.8 | 2.0  | V    |  |  |  |  |
| T <sub>A</sub>    | Operating free-air temperature <sup>(1)</sup>                             |  | -30  | 25  | 70   | °C   |  |  |  |  |
| Power Consu       | Power Consumption   |  |      |     |      |      |  |  |  |  |
|                   | V <sub>DD</sub> =1.8V; T <sub>A</sub> =25°C<br>Active mode <sup>(3)</sup> |  | 210  | 300 | μA   |      |  |  |  |  |
| $I_{DD}$          | Supply Current <sup>(2)</sup>   | V <sub>DD</sub> =1.8V; T <sub>A</sub> =25°C<br>Idle mode <sup>(4)</sup>  |      | 35  | 60   | μΑ   |  |  |  |  |
|                   |   | V <sub>DD</sub> =1.8V; T <sub>A</sub> =25°C<br>Sleep mode <sup>(5)</sup> |      | 0.7 | 5    | μΑ   |  |  |  |  |
| Digital pins      |   |  |      |     |      |      |  |  |  |  |
| V <sub>IH</sub>   | SCL,SDA input high voltage  |  | 1.26 |     |      | V    |  |  |  |  |
| V <sub>IL</sub>   | SCL,SDA input low voltage   |  |      |     | 0.54 | V    |  |  |  |  |
| VoL               | INT, SDA output low voltage   | 6mA sink current   |      |     | 0.4  | V    |  |  |  |  |
| Cı                | Input pin capacitance   |  |      |     | 10   | pF   |  |  |  |  |
| l <sub>leak</sub> | Leakage current into SCL,SDA,INT pins                                     |  | -5   |     | 5    | μΑ   |  |  |  |  |
| GPIO              |   |  |      |     |      |      |  |  |  |  |
| CLOAD             | Maximum capacitive load GPIO  |  |      |     | 20   | pF   |  |  |  |  |

<sup>(1)</sup> While the device is operational across the temperature range, functionality will vary with temperature.

<sup>(2)</sup> Supply current values are shown at the VDD pin and do not include current through pin LDR.

<sup>(3)</sup> Active state occurs during active integration. (PON = "1"; SP\_EN = "1") If wait is enabled (WEN = "1"), supply current is lower during the wait period

<sup>(4)</sup> Idle state occurs when PON = "1" and all functions are disabled

<sup>(5)</sup> Sleep state occurs when PON = "0" and I<sup>2</sup>C bus is idle. If I<sup>2</sup>C traffic is active device automatically enters idle mode.



# **6** Optical Characteristics

All limits are guaranteed. The parameters with Min and Max values are guaranteed with production tests or SQC (Statistical Quality Control) methods. All voltages with respect to GND/PGND. Device parameters are guaranteed at VDD=1.8V and T<sub>A</sub>=25°C unless otherwise noted.

Figure 7:
Optical Characteristics of Channel F1, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions   | Min | Тур  | Max | Unit   |
|-------------------|---|--|-----|------|-----|--------|
|                   | Irradiance responsivity channel F1 <sup>(2)</sup> | LED: warm white 2700K (3)<br>Ee = 107.67µW/cm <sup>2</sup>                     |     | 55   |     | counts |
| R <sub>e_F1</sub> |   | LED: 420nm <sup>(3)</sup> Ee = 57 μW/cm <sup>2</sup> AGAIN = 512x tint = 100ms |     | 3200 |     | counts |
| $\lambda_p$       | Center wavelength <sup>(1)</sup>                  |  | 405 | 415  | 425 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |  |     | 26   |     | nm     |

<sup>(1)</sup> Parameter measured on a production ongoing sample bases on glass using diffused light

Figure 8: Optical Characteristics of Channel F2, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions  | Min | Тур | Max | Unit   |
|-------------------|---|---|-----|-----|-----|--------|
| R <sub>e_F2</sub> | Irradiance responsivity channel F2 <sup>(2)</sup> | LED: warm white 2700K <sup>(3)</sup><br>Ee = 107.67µW/cm <sup>2</sup> |     | 110 |     | counts |
| $\lambda_p$       | Center wavelength <sup>(1)</sup>                  |   | 435 | 445 | 455 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |   |     | 30  |     | nm     |

<sup>(1)</sup> Parameter measured on a production ongoing sample bases on glass using diffused light

<sup>(2)</sup> The following diffuser is used in final test on top of AS7341: ED1-C50

<sup>(3)</sup> Refer to Figure 15:

Typical LED Spectra Used in Final Test of AS7341

<sup>(2)</sup> The following diffuser is used in final test on top of AS7341: ED1-C50

<sup>(3)</sup> Refer to Figure 15:

Typical LED Spectra Used in Final Test of AS7341



Figure 9: Optical Characteristics of Channel F3, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions  | Min | Тур | Max | Unit   |
|-------------------|---|---|-----|-----|-----|--------|
| R <sub>e_F3</sub> | Irradiance responsivity channel F3 <sup>(2)</sup> | LED: warm white 2700K <sup>(3)</sup><br>Ee = 107.67µW/cm <sup>2</sup> |     | 210 |     | counts |
| λρ                | Center wavelength <sup>(1)</sup>                  |   | 470 | 480 | 490 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |   |     | 36  |     | nm     |

- (1) Parameter measured on a production ongoing sample bases on glass using diffused light
- (2) The following diffuser is used in final test on top of AS7341: ED1-C50
- (3) Refer to Figure 15: Typical LED Spectra Used in Final Test of AS7341

Figure 10:
Optical Characteristics of Channel F4, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions  | Min | Тур | Max | Unit   |
|-------------------|---|---|-----|-----|-----|--------|
| R <sub>e_F4</sub> | Irradiance responsivity channel F4 <sup>(2)</sup> | LED: warm white 2700K <sup>(3)</sup><br>Ee = 107.67µW/cm <sup>2</sup> |     | 390 |     | counts |
| $\lambda_p$       | Center wavelength <sup>(1)</sup>                  |   | 505 | 515 | 525 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |   |     | 39  |     | nm     |

- (1) Parameter measured on a production ongoing sample bases on glass using diffused light
- (2) The following diffuser is used in final test on top of AS7341: ED1-C50
- (3) Refer to Figure 15:
  Typical LED Spectra Used in Final Test of AS7341

Figure 11:
Optical Characteristics of Channel F5, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions  | Min | Тур | Max | Unit   |
|-------------------|---|---|-----|-----|-----|--------|
| R <sub>e_F5</sub> | Irradiance Responsivity channel F5 <sup>(2)</sup> | LED: warm white 2700K <sup>(3)</sup><br>Ee = 107.67μW/cm <sup>2</sup> |     | 590 |     | counts |
| $\lambda_p$       | Center wavelength <sup>(1)</sup>                  |   | 545 | 555 | 565 | nm     |
| FWHM              | Full width half maximum(1)                        |   |     | 39  |     | nm     |

- (1) Parameter measured on a production ongoing sample bases on glass using diffused light
- (2) The following diffuser is used in final test on top of AS7341: ED1-C50
- (3) Refer to Figure 15: Typical LED Spectra Used in Final Test of AS7341



Figure 12:
Optical Characteristics of Channel F6, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions  | Min | Тур | Max | Unit   |
|-------------------|---|---|-----|-----|-----|--------|
| R <sub>e_F6</sub> | Irradiance responsivity channel F6 <sup>(2)</sup> | LED: warm white 2700K <sup>(3)</sup><br>Ee = 107.67µW/cm <sup>2</sup> |     | 840 |     | counts |
| λρ                | Center wavelength <sup>(1)</sup>                  |   | 580 | 590 | 600 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |   |     | 40  |     | nm     |

- (1) Parameter measured on a production ongoing sample bases on glass using diffused light
- (2) The following diffuser is used in final test on top of AS7341: ED1-C50
- (3) Refer to Figure 15: Typical LED Spectra Used in Final Test of AS7341

Figure 13:
Optical Characteristics of Channel F7, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions   | Min | Тур  | Max | Unit   |
|-------------------|---|--|-----|------|-----|--------|
| R <sub>e_F7</sub> | Irradiance responsivity channel F7 <sup>(2)</sup> | LED: warm white<br>2700K <sup>(3)</sup><br>Ee = 107.67µW/cm <sup>2</sup> |     | 1350 |     | counts |
| $\lambda_{p}$     | Center wavelength <sup>(1)</sup>                  |  | 620 | 630  | 640 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |  |     | 50   |     | nm     |

- (1) Parameter measured on a production ongoing sample bases on glass using diffused light
- (2) The following diffuser is used in final test on top of AS7341: ED1-C50
- (3) Refer to Figure 15:
  Typical LED Spectra Used in Final Test of AS7341



Figure 14:
Optical Characteristics of Channel F8, AGAIN: 64x, Integration Time: 27.8ms

| Symbol            | Parameter   | Conditions  | Min | Тур  | Max | Unit   |
|-------------------|---|---|-----|------|-----|--------|
| R <sub>e_F8</sub> | Irradiance responsivity channel F8 <sup>(2)</sup> | LED: warm white $2700K^{(3)}$<br>Ee = $107.67\mu$ W/cm <sup>2</sup> |     | 1070 |     | counts |
| $\lambda_{p}$     | Center wavelength <sup>(1)</sup>                  |   | 670 | 680  | 690 | nm     |
| FWHM              | Full width half maximum <sup>(1)</sup>            |   |     | 52   |     | nm     |

- (1) Parameter measured on a production ongoing sample bases on glass using diffused light
- (2) The following diffuser is used in final test on top of AS7341: ED1-C50
- (3) Refer to Figure 15: Typical LED Spectra Used in Final Test of AS7341

Figure 15:
Typical LED Spectra Used in Final Test of AS7341

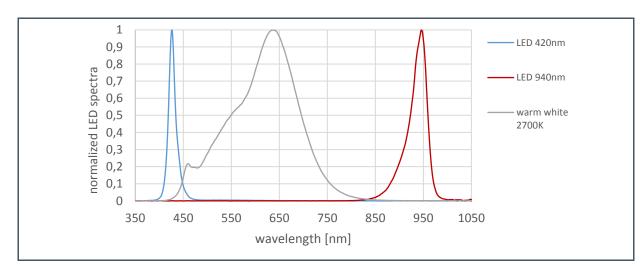




Figure 16:
Optical Characteristics of AS7341, AGAIN: 64x, Integration Time: 27.8ms (unless otherwise noted)

| Symbol                       | Parameter                                     | Conditions   | Min    | Тур   | Max    | Unit            |  |
|------------------------------|---|--|--------|-------|--------|-----------------|--|
| R <sub>e_CLEAR</sub>         | Irradiance<br>responsivity channel<br>CLEAR   | LED: warm white<br>2700Κ <sup>(5)</sup><br>Ee = 107.67μW/cm²                   |        | 1750  |        | counts          |  |
| R <sub>e_</sub> FLICKER      | Irradiance<br>responsivity channel<br>FLICKER | LED: warm white<br>2700K <sup>(5)</sup><br>Ee = 52.32µW/cm <sup>2</sup>        |        | 6810  |        | counts          |  |
|                              |   | LED: warm white<br>2700K <sup>(5)</sup><br>Ee = 107.67μW/cm <sup>2</sup>       |        | 112   |        |                 |  |
| R <sub>e_NIR</sub>           | Irradiance<br>responsivity channel<br>NIR     | LED: 940nm <sup>(5)</sup> Ee = 98 μW/cm <sup>2</sup> AGAIN = 128x tint = 100ms |        | 5135  | 5135   |                 |  |
| Dark_1 <sup>(1)(6)</sup>     | Dark ADC 0-4 count value                      | Ee = 0μW/cm²<br>AGAIN: 512x<br>Integration time: 98ms                          |        | 0     | 3      | counts          |  |
| Dark_2 <sup>(6)</sup>        | Dark ADC 5 count value                        | Ee = 0μW/cm²<br>AGAIN: 512x<br>Integration time: 98ms                          |        | 0     | 5      | counts          |  |
|                              |   | AGAIN: 0.5x  | 0.007  | 0.008 | 0.009  |                 |  |
|                              |   | AGAIN: 1x  | 0.0145 | 0.016 | 0.0175 | _               |  |
|                              |   | AGAIN: 2x  | 0.03   | 0.032 | 0.034  | _               |  |
|                              |   | AGAIN: 4x  | 0.062  | 0.065 | 0.068  | _               |  |
|                              | Optical gain ratios,                          | AGAIN: 8x  | 0.119  | 0.125 | 0.131  | _               |  |
| Gain <sup>(2)</sup><br>ratio | relative to 64x gain                          | AGAIN: 16x   | 0.237  | 0.25  | 0.263  | _               |  |
| 14.10                        | setting                                       | AGAIN: 32x   | 0.47   | 0.5   | 0.53   | _               |  |
|                              |   | AGAIN: 64x   |        | 1     |        | _               |  |
|                              |   | AGAIN: 128x  | 1.8    | 2     | 2.1    | _               |  |
|                              |   | AGAIN: 256x  | 3.75   | 3.95  | 4.25   | _               |  |
|                              |   | AGAIN: 512x  | 7.25   | 7.75  | 8.25   | _               |  |
| ADC<br>noise <sup>(3)</sup>  |   | AGAIN: 16x<br>Integration time: 10ms   |        | 0.005 |        | % full<br>scale |  |
| t <sub>int</sub>             | Typical integration time <sup>(4)</sup>       | ASTEP = 599<br>ATIME = 29  |        | 50    |        | ms              |  |
| tastep                       | Integration time step size                    | ASTEP = 999  |        | 2.78  |        | ms              |  |



| Symbol          | Parameter       | Conditions    | Min | Тур | Max | Unit |
|-----------------|-----------------|---------------|-----|-----|-----|------|
| h <sub>ca</sub> | Half cone angle | On the sensor |     | 40  |     | deg  |

- (1) The typical 3-sigma distribution is between 0 and 1 counts for AGAIN setting of 16x.
- (2) The gain ratios are calculated relative to the response with integration time: 27.8ms and AGAIN: 64x.
- (3) ADC noise is calculated as the standard deviation of 1000 data samples divided by full scale.
- (4) Integration time, in milliseconds, is equal to: (ATIME + 1) x (ASTEP + 1) x 2.78μs
- (5) Refer to Figure 15:
  - Typical LED Spectra Used in Final Test of AS7341
- (6) Register 0xD6 / AZ\_CONFIG is set to "1" auto zero done before every integration cycle



# 7 Typical Operating Characteristics

Figure 17:
Normalized Spectral Responsivity

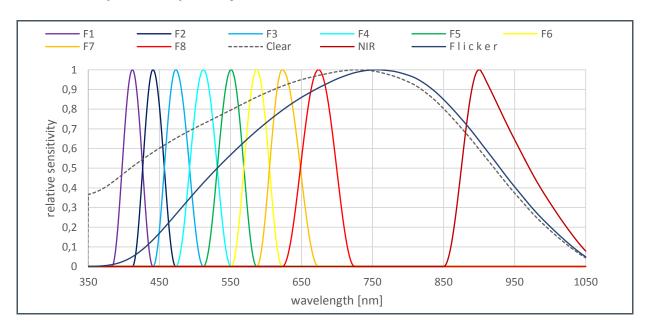
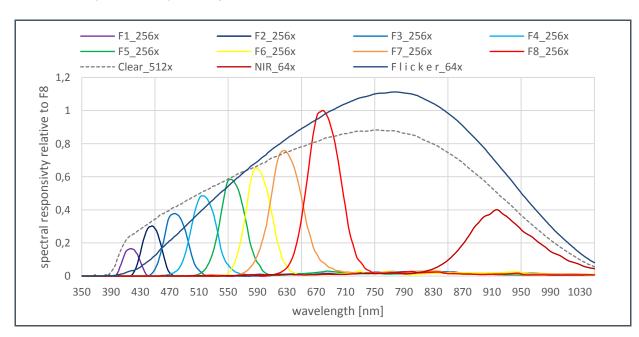


Figure 18:
Measured Spectral Responsivity Relative to F8<sup>(1)</sup>



(1) Fx\_256x...AGAIN = 256x, diffuser mounted on top of package surface

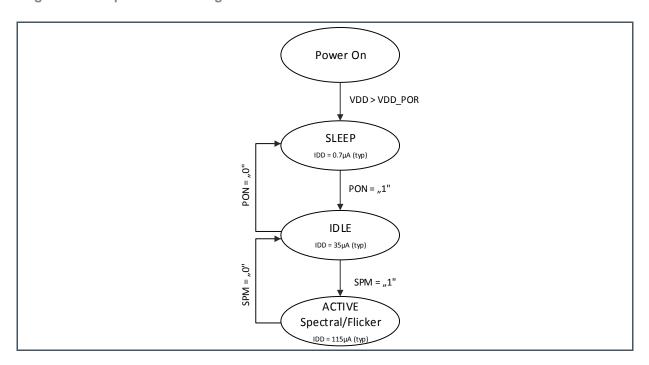


# 8 Functional Description

Upon power-up (POR), the device initializes. During initialization (typically 200µs), the device will deterministically send NAK on I²C and cannot accept I²C transactions. All communication with the device must be delayed and all outputs from the device must be ignored including interrupts. After initialization, the device enters the SLEEP state. In this operational state, the internal oscillator and other circuitry are not active, resulting in ultra-low power consumption. If an I²C transaction occurs during this state, the I²C core wakes up temporarily to service the communication. Once the Power ON bit, "PON", is enabled, the device enters the IDLE state in which the internal oscillator and attendant circuitry are active, but power consumption remains low. Whenever the spectral measurement is enabled (SP\_EN = "1") the device enters the ACTIVE state. If the spectral measurement is disabled (SP\_EN = "0") the device returns to the IDLE state. The figure below describes a simplified state diagram and the typical supply currents in each state.

If Sleep after Interrupt is enabled (SAI = "1" in register 0xAC), the state machine will enter SLEEP when an interrupt occurs. Entering SLEEP does not automatically change any of the register settings (e.g. PON bit is still high, but the normal operational state is over-ridden by SLEEP state). SLEEP state is terminated when the SAI\_ACTIVE bit is cleared (the status bit is in register 0xA7 and the clear status bit is in register 0xFA).

Figure 19: Simplified State Diagram

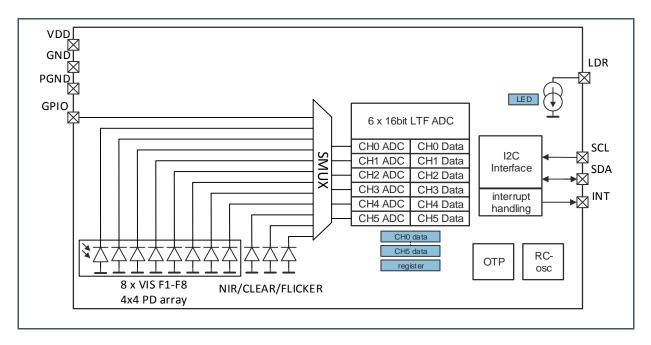




### 8.1 Channel Architecture

The device features 6 independent optical channels with a dedicated 16-bit light-to-frequency converter. Gain and integration time of the 6 channels can be adjusted with the serial interface. A wait time can be programed to automatically set a delay between two consecutive spectral measurements and to reduce overall power consumption. The other available channels can be accessed by a multiplexer (SMUX) connecting them to one of the internal ADCs.

Figure 20: Simplified Block Diagram

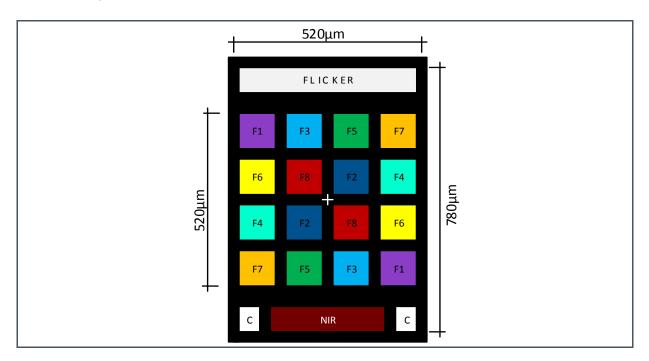




## 8.2 Sensor Array

The device features a 4x4-photodiode array. On top and below the photodiode array there are two photodiodes with dedicated functions such as flicker detection ("FLICKER") and near- infrared response ("NIR"). A clear channel ("C") – photodiode without filter – is provided at the left and right bottom corner. Each of the filter pairs can be mapped to one of the six internal ADCs (CH0 – CH5).

Figure 21: Sensor Array



## 8.3 GPIO/INT

The GPIO can be either used as input for external photodiodes (e.g. InGaAs) or as synchronization input to start/stop the spectral measurement. (SYNS/SYND mode)

The interrupt output pin INT can also be used to indicate the status (READY/BUSY) of the spectral measurement in mode SYNS and SYND.

## 8.4 SMUX

The device integrates a multiplexer (SMUX). With the SMUX, it is possible to map all available photo diodes to one of the six available light-to-frequency converter (ADC0 to ADC5). After power up of the device the SMUX needs to be configured before a spectral measurement is started. **ams** provides reference codes and an application note on how to configure the SMUX.



## 8.5 Integration Mode

The device features three modes to perform a spectral measurement. The integration mode (INT\_MODE) can be configured in register 0x70 (CONFIG). For auto zero configuration refer to register 0xD6.

Figure 22: Integration Mode Description

| Mode   | Description   | Synchronization  | Integration Time   | Registers   |
|--|---|------------------|--|---|
| SPM (spectral measurement, no sync)  INT_MODE = 0x0          | Default setting: Integration is started with bit SP_EN = "1". Integration Time is set by register ATIME and ASTEP.  | No               | ATIME [7:0]<br>ASTEP [15:0]                                  | SP_EN = "1"<br>INT_MODE = 0x0<br>ATIME [7:0]<br>ASTEP [15:0]<br>WTIME [7:0] |
| SYNS (spectral measurement, start sync)  INT_MODE = 0x1      | Integration with external start: Integration is started with rising/falling edge on pin GPIO. Integration Time is set by register ATIME and ASTEP.  | Yes (start)      | ATIME [7:0]<br>ASTEP [15:0]                                  | SP_EN = "1"<br>INT_MODE = 0x1<br>ATIME [7:0]<br>ASTEP [15:0]<br>WTIME [7:0] |
| SYND (spectral measurement, start/stop sync)  INT_MODE = 0x3 | Integration with external start and stop: Integration is controlled via rising/falling edge on pin GPIO and register EDGE. If the number of edges on pin GPIO is reached, integration time is stopped. Actual integration time can be read out in register "ITIME". | Yes (start/stop) | Rising/falling edge<br>on pin GPIO and<br>register EDGE[7:0] | SP_EN = "1" INT_MODE = 0x3 EDGE[7:0] ITIME[23:0]                            |

Figure 23 : SPM Mode

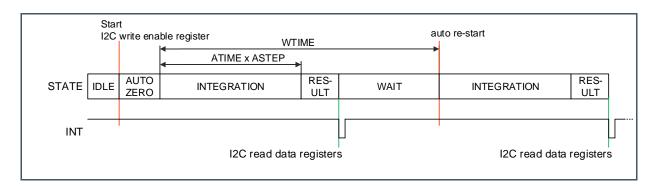




Figure 24 : SYNS Mode

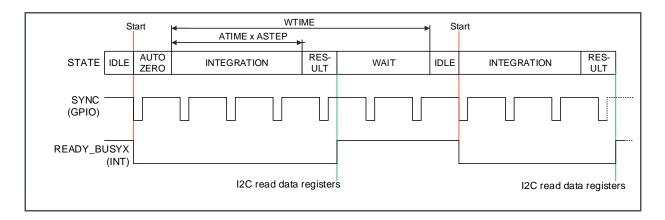
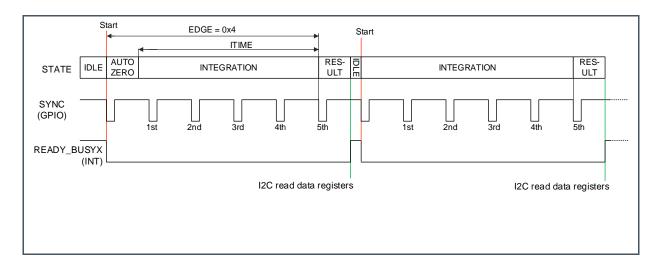


Figure 25 : SYND Mode





## 9 I<sup>2</sup>C Interface

The device uses I<sup>2</sup>C serial communication protocol for communication. The device supports 7-bit chip addressing and both standard and full-speed clock frequency modes. Read and Write transactions comply with the standard set by Philips (now NXP). Internal to the device, an 8-bit buffer stores the register address location of the desired byte to read or write. This buffer auto-increments upon each byte transfer and is retained between transaction events (i.e. valid even after the master issues a STOP command and the I<sup>2</sup>C bus is released). During consecutive Read transactions, the future/repeated I<sup>2</sup>C Read transaction may omit the memory address byte normally following the chip address byte; the buffer retains the last register address +1. All 16-bit fields have a latching scheme for reading and writing. In general, it is recommended to use I<sup>2</sup>C bursts whenever possible, especially in this case when accessing two bytes of one logical entity. When reading these fields, the low byte must be read first, and it triggers a 16-bit latch that stores the 16-bit field. The high byte must be read immediately afterwards. When writing to these fields, the low byte must be written first, immediately followed by the high byte. Reading or writing to these registers without following these requirements will cause errors.

### 9.1 I<sup>2</sup>C Address

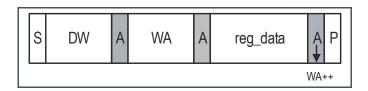
Figure 26: AS7341 I<sup>2</sup>C Slave Address

| Device | I <sup>2</sup> C Address |
|--------|--------------------------|
| AS7341 | 0x39                     |

## 9.2 I<sup>2</sup>C Write Transaction

A Write transaction consists of a START, CHIP-ADDRESSWRITE, REGISTER-ADDRESS WRITE, DATA BYTE(S), and STOP (P). Following each byte (9TH clock pulse) the slave places an ACKNOWLEDGE/NOT- ACKNOWLEDGE (A/N) on the bus. If the slave transmits N, the master may issue a STOP.

Figure 27: I<sup>2</sup>C Byte Write

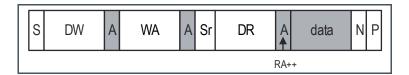




### 9.3 I<sup>2</sup>C Read Transaction

A Read transaction consists of a START, CHIP-ADDRESSWRITE, REGISTER-ADDRESS, RESTART, CHIP-ADDRESSREAD, DATA BYTE(S), and STOP. Following all but the final byte the master places an ACK on the bus (9TH clock pulse). Termination of the Read transaction is indicated by a NACK being placed on the bus by the master, followed by STOP.

Figure 28: I<sup>2</sup>C Read



## 9.4 Timing Characteristics

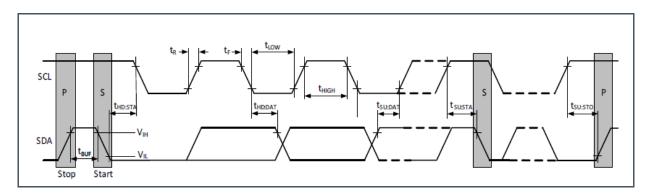
Figure 29: I<sup>2</sup>C Timing Characteristics

| Symbol              | Parameter  | Min | Тур | Max | Unit |
|---------------------|--|-----|-----|-----|------|
| fscL                | I <sup>2</sup> C clock frequency   |     |     | 400 | kHz  |
| t <sub>BUF</sub>    | Bus free time between start and stop condition   | 1.3 |     |     | μs   |
| ths;sta             | Hold time after (repeated) start condition. After this period, the first clock is generated. | 0.6 |     |     | μs   |
| t <sub>SU;STA</sub> | Repeated start condition setup time  | 0.6 |     |     | μs   |
| tsu;sto             | Stop condition setup time  | 0.6 |     |     | μs   |
| tLOW                | SCL clock low period   | 1.3 |     |     | μs   |
| tніgн               | SCL clock high period  | 0.6 |     |     | μs   |
| thd;dat             | Data hold time   | 0   |     |     | ns   |
| tsu;dat             | Data setup time  | 100 |     |     | ns   |
| tF                  | Clock/data fall time   |     |     | 300 | ns   |
| t <sub>R</sub>      | Clock/data rise time   |     |     | 300 | ns   |



# 9.5 Timing Diagrams

Figure 30: I<sup>2</sup>C Slave Timing Diagram





# 10 Register Description

The device is controlled and monitored by registers accessed through the I<sup>2</sup>C serial interface. These registers provide device control functions and can be read to determine device status and acquire device data.

The register set is summarized below. The values of all registers and fields that are listed as reserved or are not listed must not be changed at any time. Two-byte fields are always latched with the low byte followed by the high byte. The "Name" column illustrates the purpose of each register by highlighting the function associated to each bit. The bits are shown from MSB (D7) to LSB (D0). GRAY fields are reserved and their values must not be changed at any time.

In order to access registers from 0x60 to 0x74 bit REG\_BANK in register CFG0 (0xA9) needs to be set to "1".

## 10.1 Register Overview

Figure 31: Register Overview

| Addr | Name       | <d7></d7>       | <d6></d6>          | <d5></d5> | <d4></d4>       | <d3></d3>        | <d2:< th=""><th>&gt; <d1></d1></th><th><d0></d0></th></d2:<> | > <d1></d1> | <d0></d0> |  |  |
|------|------------|-----------------|--------------------|-----------|-----------------|------------------|--|-------------|-----------|--|--|
| 0x60 | ASTATUS    | ASAT_<br>STATUS | AGAIN STATUS [3:0] |           |                 |                  |  |             |           |  |  |
| 0x61 | CHO DATA   |                 |                    |           | CH              | CH0_DATA_L [7:0] |  |             |           |  |  |
| 0x62 | - CH0_DATA |                 |                    |           | CHO             | DATA_H [7        | 7:0]   |             |           |  |  |
| 0x63 |            |                 |                    |           | I               | TIME_L [7:0]     |  |             |           |  |  |
| 0x64 | ITIME      |                 |                    |           | ľ               | ITIME_M [7:0]    |  |             |           |  |  |
| 0x65 |            |                 |                    |           | Į.              | ITIME_H [7:0]    |  |             |           |  |  |
| 0x66 | CIII DATA  |                 |                    |           |                 |                  | CH1_DATA_L [7:0]   |             |           |  |  |
| 0x67 | - CH1_DATA |                 |                    |           | CH <sup>2</sup> | CH1_DATA_H [7:0] |  |             |           |  |  |
| 0x68 | CU2 DATA   |                 |                    |           | CH              | CH2_DATA_L [7:0] |  |             |           |  |  |
| 0x69 | - CH2_DATA |                 |                    |           | CH2             | CH2_DATA_H [7:0] |  |             |           |  |  |
| 0x6A | - CH3 DATA |                 |                    |           | CH:             | CH3_DATA_L [7:0] |  |             |           |  |  |
| 0x6B | - CH3_DATA |                 |                    |           | CH              | CH3_DATA_H [7:0] |  |             |           |  |  |
| 0x6C | CHA DATA   |                 |                    |           | CH              | 4_DATA_L [7      | <b>'</b> :0]   |             |           |  |  |
| 0x6D | - CH4_DATA |                 |                    |           | CH4             | 1_DATA_H [7      | 7:0]   |             |           |  |  |
| 0x6E | CHE DATA   |                 |                    |           | CH              | 5_DATA_L [7      | 7:0]   |             |           |  |  |
| 0x6F | - CH5_DATA |                 |                    |           | CH              | 5_DATA_H [7      | 7:0]   |             |           |  |  |
| 0x70 | CONFIG     |                 |                    |           |                 | LED_SEL          | INT_SEL  | INT_MO      | DE[1:0]   |  |  |
| 0x71 | STAT       |                 |                    |           |                 |                  |  | WAIT_SYNC   | READY     |  |  |
| 0x72 | EDGE       |                 | SYNC_EDGE [7:0]    |           |                 |                  |  |             |           |  |  |



| Addr         | Name       | <d7></d7>           | <d6></d6>                            | <d5></d5>     | <d4></d4>         | <d3></d3>        | <d2></d2> | <d1></d1>     | <d0></d0>     |  |  |
|--------------|------------|---------------------|--------------------------------------|---------------|-------------------|------------------|-----------|---------------|---------------|--|--|
| 0x73         | GPIO       | _                   | _                                    | _             | _                 | _                | F         | PD_GPIO       | PD_INT        |  |  |
| 0x74         | LED        | LED_ACT             | Г                                    |               |                   | LED_DRIVE        |           |               |               |  |  |
| 0x80         | ENABLE     |                     | FDEN                                 | N N           | SMUXEN            |                  | ,,        | SP_EN         | PON           |  |  |
| 0x81         | ATIME      |                     |                                      |               |                   | ME [7:0]         |           |               |               |  |  |
| 0x83         | WTIME      |                     |                                      |               |                   | ME [7:0]         |           |               |               |  |  |
| 0x84         |            |                     |                                      |               |                   | L_LSB [7:0]      |           |               |               |  |  |
| 0x85         | - SP_TH_L  |                     | SP_TH_L_MSB [7:0]                    |               |                   |                  |           |               |               |  |  |
| 0x86         |            |                     |                                      |               |                   |                  |           |               |               |  |  |
| 0x87         | SP_TH_H    |                     | SP_TH_H_LSB [7:0]  SP_TH_H_MSB [7:0] |               |                   |                  |           |               |               |  |  |
| 0x87<br>0x90 | AUXID      |                     |                                      |               |                   |                  |           |               |               |  |  |
|              |            |                     |                                      |               |                   | (ID [7:0]        |           |               |               |  |  |
| 0x91         | REVID      |                     |                                      |               |                   | /ID [7:0]        |           |               |               |  |  |
| 0x92         | ID         | A O A T             |                                      |               | IL                | ) [7:0]          | FILIT     | OINT          | OINIT         |  |  |
| 0x93         | STATUS     | ASAT                |                                      |               |                   | AINT             | FINT      | CINT          | SINT          |  |  |
| 0x94         | ASTATUS    | ASAT_<br>STATU<br>S |                                      |               |                   |                  | AGAIN_ST  | ATUS [3:0]    |               |  |  |
| 0x95         |            |                     |                                      |               | CH0_D             | L<br>ATA_L [7:0] |           |               |               |  |  |
| 0x96         | - CH0_DATA |                     | CH0_DATA_H [7:0]                     |               |                   |                  |           |               |               |  |  |
| 0x97         |            |                     | CH1_DATA_L [7:0]                     |               |                   |                  |           |               |               |  |  |
| 0x98         | - CH1_DATA |                     |                                      |               |                   | ATA_H [7:0]      |           |               |               |  |  |
| 0x99         |            |                     |                                      |               |                   | ATA_L [7:0]      |           |               |               |  |  |
| 0x9A         | - CH2_DATA |                     |                                      |               |                   | ATA_H [7:0]      |           |               |               |  |  |
| 0x9B         |            |                     |                                      |               |                   | ATA_L [7:0]      |           |               |               |  |  |
| 0x9C         | - CH3_DATA |                     |                                      |               |                   | ATA_H [7:0]      |           |               |               |  |  |
| 0x9D         |            |                     |                                      |               |                   | ATA_L [7:0]      |           |               |               |  |  |
| 0x9E         | - CH4_DATA |                     |                                      |               |                   | ATA_H [7:0]      |           |               |               |  |  |
| 0x9F         |            |                     |                                      |               |                   | ATA_L [7:0]      |           |               |               |  |  |
| 0xA0         | CH5_DATA   |                     |                                      |               |                   | ATA_H [7:0]      |           |               |               |  |  |
| 0xA3         | STATUS 2   |                     | AVALI<br>D                           |               | ASAT_<br>DIG      | ASAT_<br>ANA     |           | FDSAT<br>_ANA | FDSAT_<br>DIG |  |  |
| 0xA4         | STATUS 3   |                     |                                      | INT_SP_<br>H  | INT_SP_L          |                  |           |               |               |  |  |
| 0xA6         | STATUS 5   |                     |                                      |               |                   | SINT_FD          |           |               |               |  |  |
| 0xA7         | STATUS 6   | FIFO_<br>OV         |                                      | OVTEMP        | FD_TRIG           |                  | SP_TRIG   | SAI_<br>ACT   | INT_BUS<br>Y  |  |  |
| 0xA9         | CFG 0      |                     |                                      | LOW_<br>POWER |                   | REG_<br>BANK     | WLONG     |               |               |  |  |
| 0xAA         | CFG 1      |                     | AGAIN[4:0]                           |               |                   |                  |           |               |               |  |  |
| 0xAC         | CFG 3      |                     | SAI                                  |               |                   |                  |           |               |               |  |  |
| 0xAF         | CFG 6      |                     |                                      |               | SMUX_<br>CMD[4:3] | ]                |           |               |               |  |  |
| 0xB1         | CFG 8      | FIFO_TH             | [7:6]                                |               |                   | FD_AGC           | SP_AGC    |               |               |  |  |
|              |            |                     |                                      |               |                   |                  |           |               |               |  |  |



| Addr | Name             | <d7></d7>   | <d6></d6>                                 | <d5></d5>    | <d4></d4>     | <d3></d3>              | <d2></d2>              | <d1></d1>    | <d0></d0>         |  |
|------|------------------|-------------|---|--------------|---------------|------------------------|------------------------|--------------|-------------------|--|
| 0xB2 | CFG 9            |             | SIEN<br>_FD                               |              | SIEN<br>_SMUX |                        |                        |              |                   |  |
| 0xB3 | CFG 10           | AGC_H [7    | ':6]                                      | AGC_L[7:6]   |               |                        | F                      | D_PERS [2    | 2:0]              |  |
| 0xB5 | CFG 12           |             |   |              |               |                        | S                      | P_TH_CH [    | 2:0]              |  |
| 0xBD | PERS             |             |   |              |               |                        | APERS                  | S [3:0]      |                   |  |
| 0xBE | GPIO 2           |             |   |              |               | GPIO_<br>INV           | GPIO_<br>IN            | GPIO_<br>OUT | GPIO_<br>IN       |  |
| 0xCA | ACTED            |             |   |              | AST           | EP [7:0]               |                        |              |                   |  |
| 0xCB | ASTEP            |             | ASTEP [15:8]                              |              |               |                        |                        |              |                   |  |
| 0xCF | AGC_GAIN_M<br>AX |             | AGC_FD_GAIN_MAX [7:4] AGC_AGAIN_MAX [3:0] |              |               |                        |                        |              |                   |  |
| 0xD6 | AZ_CONFIG        |             | AT_NTH_ITERATION [7:0]                    |              |               |                        |                        |              |                   |  |
| 0xD8 | FD_TIME 1        |             | FD_TIME [7:0]                             |              |               |                        |                        |              |                   |  |
| 0xDA | FD_TIME 2        |             | FD.                                       | _GAIN [7:3]  |               |                        | FD_TIM                 | IE [10:8]    |                   |  |
| 0xD7 | FD_CFG0          | FD_<br>FIFO |   |              |               |                        |                        |              |                   |  |
| 0xDB | FD_STATUS        |             |   | FD_<br>VALID | FD_<br>SAT    | FD_<br>120HZ_<br>VALID | FD_<br>100Hz_<br>VALID | FD_<br>120Hz | FD_<br>100Hz      |  |
| 0xF9 | INTENAB          | ASIEN       |   |              |               | SP_IEN                 | FIEN                   | CIEN         | SIEN              |  |
| 0xFA | CONTROL          |             |   |              |               |                        | AZ_SP_<br>MAN          | FIFO_<br>CLR | CLEAR_<br>SAI_ACT |  |
| 0xFC | FIFO_MAP         |             | FIFO_W                                    | RITE_CH5_D   | ATA – FIFO_\  | WRITE_CH0_D            | OATA [6:1]             |              | ASTATU<br>S       |  |
| 0xFD | FIFO_LVL         | FIFO_LVL    | [7:0]                                     |              |               |                        |                        |              |                   |  |
| 0xFE | - FDATA          | FDATA [7    | :0]                                       |              |               |                        |                        |              |                   |  |
| 0xFF | - FDATA          |             |   |              | FDA           | TA [15:8]              |                        |              |                   |  |

## 10.2 Detailed Register Description

For easier readability, the detailed register description is done in groups of registers related to dedicated device functions. This is not necessarily related to its register address.

Explanation of register access abbreviations:

RW = read or write

R = read only

W = write only

SC = self-clearing after access



### 10.2.1 Enable and Configuration Register

The following registers are needed to power up and configure the device. To operate the device set bit PON = "1" first (register 0x80) after that configure the device and enable interrupts before setting SP\_EN = "1". Changing configuration while SP\_EN = "1" may result in invalid results. Register CONFIG (0x70) is used to set the INT\_MODE (SYNS,SYND).

#### **ENABLE Register (Address 0x80)**

Figure 32: ENABLE Register

| Addr: | 0x80     | ENABLE  |        |   |
|-------|----------|---------|--------|---|
| Bit   | Bit Name | Default | Access | Bit Description   |
| 7     | reserved | 0       | RW     | reserved  |
| 6     | FDEN     | 0       | RW     | Flicker Detection Enable. 0: Flicker Detection disabled 1: Flicker Detection enabled  |
| 5     | reserved | 0       | RW     | reserved  |
| 4     | SMUXEN   | 0       | RW     | SMUX Enable.  1: Starts SMUX command  Note: this bit gets cleared automatically as soon as SMUX operation is finished                                   |
| 3     | WEN      | 0       | RW     | Wait Enable.  0: Wait time between two consecutive spectral measurements disabled  1: Wait time between two consecutive spectral measurements enabled   |
| 2     | reserved | 0       | RW     | reserved  |
| 1     | SP_EN    | 0       | RW     | Spectral Measurement Enable. 0: Spectral Measurement Disabled 1: Spectral Measurement Enabled   |
| 0     | PON      | 0       | RW     | Power ON.  0: AS7341 disabled  1: AS7341 enabled  Note: When bit is set, internal oscillator is activated, allowing timers and ADC channels to operate. |



### **CONFIG Register (Address 0x70)**

Figure 33: CONFIG Register

| Addr: 0x70 |          | CONFIG  | CONFIG |   |  |
|------------|----------|---------|--------|---|--|
| Bit        | Bit Name | Default | Access | Bit Description   |  |
| 7:4        | reserved | 0       | RW     | reserved  |  |
| 3          | LED_SEL  | 0       | RW     | LED control.  0: External LED not controlled by AS7341  1: Register LED controls LED connected to pin LDR  Note: register 0x74  |  |
| 2          | INT_SEL  | 0       | RW     | 1: Sync signal applied on output pin INT  |  |
| 1:0        | INT_MODE | 0       | RW     | Ambient light sensing mode:  0: SPM mode (spectral measurement, normal mode)  1: SYNS mode  2: reserved  3: SYND mode  Note: in SYND mode it is recommended to use register 0x60 to 0x6F to read out spectral data. |  |

### GPIO Register (Address 0x73)

Figure 34: GPIO Register

| Addr: ( | 0x73     | GPIO    |        |                                      |
|---------|----------|---------|--------|--------------------------------------|
| Bit     | Bit Name | Default | Access | Bit Description                      |
| 7:2     | reserved | 0       | RW     | reserved                             |
| 1       | PD_GPIO  | 0       | RW     | 1: Photo diode connected to pin GPIO |
| 0       | PD_INT   | 0       | RW     | 1: Photo diode connected to pin INT  |



### GPIO 2 Register (Address 0xBE)

Figure 35: GPIO2 Register

| Addr: | 0xBE       | GPIO 2  | GPIO 2 |  |
|-------|------------|---------|--------|--|
| Bit   | Bit Name   | Default | Access | Bit Description  |
| 7:4   | reserved   | 0       |        | reserved   |
| 3     | GPIO_INV   | 0       | RW     | GPIO Invert. If set, the GPIO output is inverted.                        |
| 2     | GPIO_IN_EN | 0       | RW     | GPIO Input Enable.  If set, the GPIO pin accepts a non-floating input.   |
| 1     | GPIO_OUT   | 1       | RW     | GPIO Output.  If set, the output state of the GPIO is active directly.   |
| 0     | GPIO_IN    | 0       | R      | GPIO Input. Indicates the status of the GPIO input if GPIO_IN_EN is set. |

### LED Register (Address 0x74)

Figure 36: LED Register

| Addr: 0x74 |           | LED      |        |  |
|------------|-----------|----------|--------|--|
| Bit        | Bit Name  | Default  | Access | Bit Description  |
| 7          | LED_ACT   | 0        | RW     | LED control.  0: External LED connected to pin LDR off  1: External LED connected to pin LDR on  |
| 6:0        | LED_DRIVE | 000 0100 | RW     | LED driving strength.  000 0000: 4mA  000 0001: 6mA  000 0010: 8mA  000 0011: 10mA  000 0100: 12mA   111 1110: 256mA  111 1111: 258mA  Note: Bit LED_SEL (register 0x70) needs to be set to "1" to control LED connected to pin LDR. |



### INTENAB Register (Address 0xF9)

Figure 37:

**INTENAB** Register

| Addr: 0xF9 |          | INTENAB | INTENAB  |  |  |
|------------|----------|---------|----------|--|--|
| Bit        | Bit Name | Default | Access   | Bit Description  |  |
| _          | 401511   |         | DW       | Spectral and Flicker Detect Saturation Interrupt Enable.   |  |
| 7          | ASIEN    | 0       | RW       | When asserted permits saturation interrupts to be generated.   |  |
| 6:4        | reserved |         | reserved |  |  |
|            |          |         |          | Spectral Interrupt Enable.   |  |
| 3          | SP_IEN   | 0       | RW       | When asserted permits interrupts to be generated, subject to the spectral thresholds and persistence filter. Bit is mirrored in the ENABLE register. |  |
|            |          |         |          | FIFO Buffer Interrupt Enable.  |  |
| 2          | F_IEN    | 0       | RW       | When asserted permits interrupt to be generated when FIFO_LVL exceeds the FIFO threshold condition.  |  |
| 1          | reserved | 0       |          | reserved   |  |
|            |          |         |          | System Interrupt Enable.   |  |
| 0          | SIEN     |         | RW       | When asserted permits system interrupts to be generated. Indicates that flicker detection status has changed or SMUX operation has finished.         |  |

### CONTROL Register (Address 0xFA)

Figure 38:

**CONTROL** Register

| Addr: 0xFA |               | CONTROL | CONTROL  |  |
|------------|---------------|---------|--|--|
| Bit        | Bit Name      | Default | Access   | Bit Description  |
| 7:3        | reserved      | 0       |  | reserved   |
|            |               |         |  | Spectral Engine Manual Autozero.   |
| 2          | SP_MAN_AZ     | 0       | RW   | Starts a manual autozero of the spectral engines.<br>Set SP_EN = 0 before starting a manual autozero for it to work. |
|            |               |         |  | FIFO Buffer Clear.   |
| 1          | FIFO_CLR 0 RW | RW      | Clears all FIFO data, FINT, FIFO_OV, and FIFO_LVL. |  |
|            |               |         |  | Clear Sleep-After-Interrupt Active.  |
| 0          | CLEAR_SAI_ACT | 0       | RW   | Clears SAI_ACTIVE, ends sleep, and restarts device operation.  |



### 10.2.2 ADC Timing Configuration / Integration Time

The integration time in INT\_MODE = "00" and "01" (SPM/SYNS) is set using the ATIME (0x81) and ASTEP (0xCA, 0xCB) registers. The integration time, in milliseconds, is equal to:

#### **Equation 1: Setting the integration time**

$$t_{int} = (ATIME + 1) \times (ASTEP + 1) \times 2.78 \mu s$$

The reset value for ASTEP is 999 (2.78ms) and the recommended configuration for these two registers is ASTEP = 599 and ATIME = 29, which results in an integration time of 50ms. It is not allowed that both settings –ATIME and ASTEP – are set to "0".

The integration time also defines the full-scale ADC value, which is equal to:

**Equation 2: ADC full scale value** 

$$ADC_{fullscale} = (ATIME + 1) \times (ASTEP + 1)$$

#### ATIME Register (Address 0x81)

Figure 39:

**ATIME** Register

| Addr: 0x81 |          | ATIME   | ATIME  |                 |  |  |  |
|------------|----------|---------|--------|-----------------|--|--|--|
| Bit        | Bit Name | Default | Access | Bit Descrip     | tion                                       |  |  |
|            |          |         |        | Integration tin | ne. er of integration steps from 1 to 256. |  |  |
|            |          | 0x00    | RW     | Value           | Integration Time                           |  |  |
| 7:0        | ATIME    |         |        | 0               | ASTEP                                      |  |  |
|            |          |         |        | n               | ASTEP x (n+1)                              |  |  |
|            |          |         |        | 255             | 256 x ASTEP                                |  |  |



### ASTEP Register (Address 0xCA, 0xCB)

Figure 40: ASTEP Register

| Addr: 0xCA, 0xCB |            | ASTEP   | ASTEP  |  |                      |  |  |
|------------------|------------|---------|--------|--|----------------------|--|--|
| Bit              | Bit Name   | Default | Access | Bit Description  | on                   |  |  |
|                  |            |         |        | Integration time step size.  Sets the integration time per step in increments of 2.78µs. The default value is 999. |                      |  |  |
| 7:0              | ASTEP 0xCA |         |        | VALUE  | STEP SIZE            |  |  |
|                  |            |         | RW     | 0  | 2.78µs               |  |  |
|                  |            | 999     |        | n  | 2.78µs x (n+1)       |  |  |
|                  |            |         |        | 599  | 1.67ms               |  |  |
|                  |            |         |        | 999  | 2.78ms               |  |  |
| 15:8             | ASTEP 0xCB |         |        | 17999  | 50ms                 |  |  |
|                  |            |         |        | 65534  | 182ms                |  |  |
|                  |            |         |        | 65535  | reserved, do not use |  |  |

### WTIME Register (Address 0x83)

If wait is enabled (WEN = "1" register 0x80), each new measurement is started based on WTIME. It is necessary for WTIME to be sufficiently long for spectral integration and any other functions to be completed within the period. The device will warn the user if the timing is configured incorrectly. If WTIME is too short, then SP\_TRIG in register STATUS6 (ADDR: 0xA7) will be set to "1".

Figure 41: WTIME Register

| Addr: 0x83 WTIME |          |         |        |                |  |                |
|------------------|----------|---------|--------|----------------|--|----------------|
| Bit              | Bit Name | Default | Access | Bit Descr      | iption   |                |
|                  |          |         | RW     | 8-bit value to | asurement Wait time.<br>specify the delay betwo<br>spectral measurements | veen two       |
|                  |          |         |        | Value          | Wait Cycles  | Wait Time      |
| 7:0              | WTIME    | 0x00    |        | 0x00           | 1  | 2.78ms         |
|                  |          |         |        | 0x01           | 2  | 5.56ms         |
|                  |          |         |        | n              | n  | 2.78ms x (n+1) |
|                  |          |         |        | 0xff           | 256  | 711ms          |



### ITIME Register (Address 0x63, 0x64, 0x65)

The register ITIME can be used to read-out the actual integration time in INT\_MODE = "11" (SYND). In SYND mode the integration time is defined by the register "EDGE" and the device is running integration until the number of falling edges on pin GPIO is reached.

Equation 3: Calculating the integration time in SYND mode

 $t_{int} = ITIME \times 2.78 \mu s$ 

Figure 42:

ITIME\_L Register

| Addr: | 0x63     | ITIME_L |        |   |
|-------|----------|---------|--------|---|
| Bit   | Bit Name | Default | Access | Bit Description                           |
| 7:0   | ITIME_L  | 0       | R      | Integration time in integration mode SYND |

Figure 43:

ITIME\_M Register

| Addr: ( | 0x64     | ITIME_M |        |   |
|---------|----------|---------|--------|---|
| Bit     | Bit Name | Default | Access | Bit Description                           |
| 15:8    | ITIME_M  | 0       | R      | Integration time in integration mode SYND |

Figure 44:

ITIME\_H Register

| Addr: 0 | )x65     | ITIME_H | ITIME_H |   |
|---------|----------|---------|---------|---|
| Bit     | Bit Name | Default | Access  | Bit Description                           |
| 23:16   | ITIME_H  | 0       | R       | Integration time in integration mode SYND |



#### EDGE Register (Address 0x72)

Figure 45: EDGE Register

| Addr: 0x72 |           | EDGE    |        |  |
|------------|-----------|---------|--------|--|
| Bit        | Bit Name  | Default | Access | Bit Description  |
| 7:0        | SYNC_EDGE | 0       | RW     | Number of falling SYNC-edges between start and stop of integration in mode SYND  Number of edges = SYNC_EDGE + 1 |

### FD\_TIME Register (Address 0xD8, 0xDA)

The register FD Time 1 and FD Time 2 can be used to configure the integration time and gain (ADC 5) of the flicker detection independently from the other ADCs. The FD\_TIME register is an 11-bit register with the MSB in register 0xDA (bit 10:8) and the LSB in register 0xD8 (bit 7:0). The bit FDEN (register 0x80) must be set to "1" in order to use the FD\_TIME registers. If the bit FDEN is not set, ADC5 runs automatically with the same gain and integration time as ADC0 to ADC4.

### **Equation 4: Calculating the flicker detection integration time**

 $t_{int\ FD} = FD\_TIME \times 2.78 \mu s$ 

#### Figure 46:

**FD Time Register** 

| Addr: 0xD8 |               | FD_TIME_ | FD_TIME_1                      |   |  |  |
|------------|---------------|----------|--------------------------------|---|--|--|
| Bit        | Bit Name      | Default  | Default Access Bit Description |   |  |  |
| 7:0        | FD_TIME [7:0] | 0        | RW                             | LSB of flicker detection integration time  Note: must not be changed during FDEN = 1 and PON = 1. |  |  |



Figure 47: FD Time Register

| Addr: 0xDA |                | FD_TIME_ | FD_TIME_2 |   |      |  |
|------------|----------------|----------|-----------|---|------|--|
| Bit        | Bit Name       | Default  | Access    | Bit Description   | on   |  |
| 7:3        |                | 9        | R/W       | Flicker Detection gain setting (ADC5)   |      |  |
|            |                |          |           | VALUE   | GAIN |  |
|            |                |          |           | 0   | 0.5x |  |
|            |                |          |           | 1   | 1x   |  |
|            |                |          |           | 2   | 2x   |  |
|            |                |          |           | 3   | 4x   |  |
|            | FD_GAIN        |          |           | 4   | 8x   |  |
|            |                |          |           | 5   | 16x  |  |
|            |                |          |           | 6   | 32x  |  |
|            |                |          |           | 7   | 64x  |  |
|            |                |          |           | 8   | 128x |  |
|            |                |          |           | 9   | 256x |  |
|            |                |          |           | 10  | 512x |  |
| 2:0        | FD_TIME [10:8] | 0        | RW        | MSB of flicker detection integration time  Note: must not be changed during FDEN = 1 and PON = 1. |      |  |



### 10.2.3 ADC Configuration (gain, AGC...)

The following registers provide configuration for the 6 integrated ADCs (CH0 to CH5). It is possible to adjust the gain, configure and enable the automatic gain control (AGC) and setup the auto zero compensation for the engines.

### CFG1 Register (Address 0xAA)

Figure 48: CFG1 Register

| Addr: 0xAA |          | CFG1    |        |   |      |
|------------|----------|---------|--------|---|------|
| Bit        | Bit Name | Default | Access | Bit Description   | n    |
| 7:5        | reserved | 0       |        | reserved  |      |
|            |          |         | RW     | Spectral engines gain setting. Sets the spectral sensitivity. |      |
|            | AGAIN    |         |        | VALUE   | GAIN |
|            |          |         |        | 0   | 0.5x |
|            |          | 9       |        | 1   | 1x   |
|            |          |         |        | 2   | 2x   |
| 4.0        |          |         |        | 3   | 4x   |
| 4:0        |          |         |        | 4   | 8x   |
|            |          |         |        | 5   | 16x  |
|            |          |         |        | 6   | 32x  |
|            |          |         |        | 7   | 64x  |
|            |          |         |        | 8   | 128x |
|            |          |         |        | 9   | 256x |
|            |          |         |        | 10  | 512x |

### CFG10 Register (Address 0xB3)

Figure 49: CFG10 Register

| Addr: 0xB3 |          | CFG10                          |    |  |
|------------|----------|--------------------------------|----|--|
| Bit        | Bit Name | Default Access Bit Description |    | Bit Description  |
| 7:6        | AGC_H    | 3                              | RW | AGC High Hysteresis.  Sets the data threshold at which AGAIN is reduced when spectral AGC mode is enabled. The threshold is automatically calculated internally as a percentage of full-scale. Note that full-scale is equal to (ATIME + 1) x (ASTEP + 1). |



| Addr: | Addr: 0xB3 |         | CFG10  |  |   |  |
|-------|------------|---------|--------|--|---|--|
| Bit   | Bit Name   | Default | Access | Bit Descriptio                         | n   |  |
|       |            |         |        | VALUE                                  | SIGNAL  |  |
|       |            |         |        | 0                                      | 50%   |  |
|       |            |         |        | 1                                      | 62.5%   |  |
|       |            |         |        | 2                                      | 75%   |  |
|       |            |         |        | 3                                      | 87.5%   |  |
|       |            |         |        | AGC Low Hyster                         | esis.   |  |
|       |            |         |        | when spectral AG is automatically ca   | shold at which AGAIN is increased C mode is enabled. The threshold lculated internally as a percentage that full-scale is equal to (ATIME +                         |  |
| 5:4   | AGC_L      | 3       | RW     | VALUE                                  | SIGNAL  |  |
|       |            |         |        | 0                                      | 12.5%   |  |
|       |            |         |        | 1                                      | 25%   |  |
|       |            |         |        | 2                                      | 37.5%   |  |
|       |            |         |        | 3                                      | 50%   |  |
| 3     | reserved   | 0       |        | reserved                               |   |  |
|       |            |         |        | Flicker Detect Pe                      | rsistence.  |  |
| 2:0   | FD_PERS    | 2       | RW     | that must be differ will be changed. F | of consecutive flicker detect results ent before the flicker detect status licker detection interrupts on SINT is setting. Flicker detect al to $2^{(FD_{PERS}-1)}$ |  |



#### AZ\_CONFIG Register (Address 0xD6)

The following register configures how often the spectral engine offsets are reset (auto zero) to compensate for changes of the device temperature. The typical time auto zero needs to be completed is 15ms.

Figure 50: AZ\_CONFIG Register

| Addr: 0xD6 |                  | AZ_CONFIG |        |   |  |
|------------|------------------|-----------|--------|---|--|
| Bit        | Bit Name         | Default   | Access | Bit Desc  | ription  |
|            |                  |           |        |   | O FREQUENCY.   |
|            |                  |           |        |   | quency at which the device performs auto spectral engines. |
|            |                  | 255       |        | Note: If FDEN = "1" auto zero is also done for ADC 5.<br>The flicker detection measurement will be interrupted<br>and restarted in this case. |  |
|            |                  |           |        | VALUE   | AUTOZERO FREQUENCY   |
| 7:0        | AZ_NTH_ITERATION |           | RW     | 0   | Never (not recommended)                                    |
|            |                  |           |        | 1   | Every integration cycle                                    |
|            |                  |           |        | 2   | Every 2 cycles   |
|            |                  |           |        |   | Every "AZ_NTH_ITERATION" cycle                             |
|            |                  |           |        | 254   | Every 254 cycles   |
|            |                  |           |        | 255   | Only before first measurement cycle                        |

### AGC\_GAIN\_MAX Register (Address 0xCF)

Figure 51:

AGC\_GAIN\_MAX Register

| Addr: 0xCF |                 | AGC_GAIN_MAX |        |  |
|------------|-----------------|--------------|--------|--|
| Bit        | Bit Name        | Default      | Access | Bit Description  |
|            |                 |              |        | Flicker Detection AGC Gain Max.  |
| 7:4        | AGC_FD_GAIN_MAX | 9            | RW     | Sets the maximum gain for flicker detection to $2^{\mathit{AGC\_FD\_GIAN\_MAX}}$ |
|            |                 |              |        | Default value is 9 (256x). The range can be set from 0 (0.5x) to 10 (512x).      |
|            |                 | 9 RW         | RW     | AGC Gain Max.  |
| 3:0        | AGC_AGAIN_MAX   |              |        | Sets the maximum gain for AGC engine to<br>2 <sup>AGC_FD_GIAN_MAX</sup>          |
|            | _ <b>_</b>      |              |        | Default value is 9 (256x). The range can be set from 0 (0.5x) to 10 (512x).      |



#### CFG8 Register (Address 0xB1)

Figure 52: CFG8 Register

| Addr: 0xB1 |          | CFG8    | CFG8   |  |  |  |  |
|------------|----------|---------|--------|--|--|--|--|
| Bit        | Bit Name | Default | Access | Bit Description  | n  |  |  |
|            |          |         |        | FIFO Threshold. Sets a threshold of first FIFO buffer in | on the FIFO level that triggers the sterrupt (FINT).                   |  |  |
|            |          |         |        | VALUE  | FIFO_LVL   |  |  |
| 7:6        | FIFO_TH  | 2       | R/W    | 0  | 1  |  |  |
|            |          |         |        | 1  | 4  |  |  |
|            |          |         |        | 2  | 8  |  |  |
|            |          |         |        | 3  | 16   |  |  |
| 5:4        | reserved | 0       |        | reserved   |  |  |  |
|            |          |         |        | Flicker Detect AC  | GC Enable.   |  |  |
| 3          | FD_AGC   | 1       | RW     |  | automatic gain control for the ne to maximize flicker signal and       |  |  |
|            |          |         |        | Spectral AGC en  | able.  |  |  |
| 2          | SP_AGC   | 0       | RW     |  | e uses automatic gain control for<br>es to maximize signal while<br>n. |  |  |
| 1          | reserved | 0       |        | reserved   |  |  |  |
| 0          | reserved | 0       |        | reserved   |  |  |  |

# 10.2.4 Device Identification

The following registers provided device identification. Device ID, revision ID and auxiliary ID are read only.

# **AUXID Register (Address 0x90)**

Figure 53: AUXID Register

| Addr: ( | 0x90     | AUXID   |        |                          |
|---------|----------|---------|--------|--------------------------|
| Bit     | Bit Name | Default | Access | Bit Description          |
| 7:4     | reserved |         |        | reserved                 |
| 3:0     | AUXID    | 000     | R      | Auxiliary identification |



#### **REVID Register (Address 0x91)**

Figure 54: REVID Register

| Addr: 0 | Addr: 0x91 REVID |         |        |                                |
|---------|------------------|---------|--------|--------------------------------|
| Bit     | Bit Name         | Default | Access | Bit Description                |
| 7:3     | reserved         |         |        | reserved                       |
| 2:0     | REV_ID           | 000     | R      | Revision number identification |

#### ID Register (Address 0x92)

Figure 55: ID Register

| Addr: 0x92 |          | ID      | ID     |   |  |
|------------|----------|---------|--------|---|--|
| Bit        | Bit Name | Default | Access | Bit Description                         |  |
| 7:2        | ID       | 001001  | R      | Part number Identification Value 001001 |  |
| 1:0        | reserved |         |        | reserved                                |  |

# 10.2.5 Spectral Interrupt Configuration

The spectral interrupt threshold registers provide 16-bit values to be used as the high and low thresholds for comparison to the 16-bit CH0\_DATA values (ADC CH0). If SP\_IEN (register 0xF9) is enabled and CH0\_DATA is not between the two thresholds for the number of consecutive measurements specified in APERS (register 0xBD) an interrupt is set.

#### SP\_TH\_L\_LSB Register (Address 0x84)

Figure 56:

SP\_TH\_L\_LSB Register

| Addr: 0x84 |             | SP_TH_L_LSB |        |   |
|------------|-------------|-------------|--------|---|
| Bit        | Bit Name    | Default     | Access | Bit Description   |
| 7:0        | SP_TH_L_LSB | 0x00        | RW     | Spectral low threshold LSB  This register provides the low byte of the low interrupt threshold (CH0). |



#### SP\_TH\_L\_MSB Register (Address 0x85)

Figure 57:

SP\_TH\_L\_MSB Register

| Addr: 0x85 |               | SP_TH_L_ | SP_TH_L_MSB |  |  |
|------------|---------------|----------|-------------|--|--|
| Bit        | Bit Name      | Default  | Access      | Bit Description  |  |
|            |               |          |             | Spectral low threshold MSB   |  |
| 7:0        |               |          |             | This register provides the high byte of the low interrupt threshold (CH0).   |  |
|            | SP TH L MSB   | 0x00     | RW          | Both SP_TH_L registers are combined to a 16-bit threshold. If the value captured by channel 0 is below the low threshold and the APERS value is reached the bit SP_IEN is set and an interrupt is generated. |  |
|            | 31 _111_L_W3B | UXUU     | KVV         | There is an 8-bit data latch implemented that stores the written low byte until the high byte is written. Both bytes will be applied at the same time to avoid an invalid threshold.                         |  |
|            |               |          |             | Note: The LSB register cannot be changed without writing to the MSB register. It is recommended to write to SP_TH_L_SB and SP_TH_L_MSB within one I <sup>2</sup> C command.                                  |  |

#### SP\_TH\_H\_LSB Register (Address 0x86)

Figure 58:

SP\_TH\_H\_LSB Register

| Addr: 0x86 |             | SP_TH_H_ | SP_TH_H_LSB |   |  |
|------------|-------------|----------|-------------|---|--|
| Bit        | Bit Name    | Default  | Access      | Bit Description   |  |
| 7:0        | SP_TH_H_LSB | 0x00     | RW          | Spectral high threshold LSB  This register provides the low byte of the high interrupt threshold (CH0). |  |

# SP \_TH\_H\_MSB Register (Address 0x87)

Figure 59:

SP \_TH\_H\_MSB Register

| Addr: 0x87 |             | SP_TH_H | SP_TH_H_MSB |   |                             |
|------------|-------------|---------|-------------|---|-----------------------------|
| Bit        | Bit Name    | Default | Access      | Bit Description   |                             |
|            |             |         |             |   | Spectral high threshold MSB |
| 7:0        | SP_TH_H_MSB | 0x00    | RW          | This register provides the high byte of the high interrupt threshold (CH0). |                             |



| Addr: 0x87 |          | SP_TH_H | SP_TH_H_MSB |   |  |
|------------|----------|---------|-------------|---|--|
| Bit        | Bit Name | Default | Access      | Bit Description   |  |
|            |          |         |             | Both SP_TH_H registers are combined to a 16-bit threshold. If the value captured by channel 0 is above the high threshold and the APERS value is reached the bit SP_IEN is set and an interrupt is generated. |  |

# CFG12 Register (Address 0xB5)

Figure 60: CFG12 Register

| Addr: | 0xB5     | CFG12   |        |                  |   |
|-------|----------|---------|--------|------------------|---|
| Bit   | Bit Name | Default | Access | Bit Description  | on  |
| 7:3   | reserved | 0       |        | reserved         |   |
|       |          |         |        | Spectral Thresho | old Channel.  |
|       |          |         |        |                  | used for interrupts, persistence and ed, to determine device status and |
|       |          |         |        | VALUE            | CHANNEL   |
| 2:0   | SP_TH_CH | 0       | RW     | 0                | CH0   |
|       |          |         |        | 1                | CH1   |
|       |          |         |        | 2                | CH2   |
|       |          |         |        | 3                | CH3   |
|       |          |         |        | 4                | CH4   |



# 10.2.6 Device Status Register

The following register provide status of the device and indicate details about saturation, interrupts, over temperature, device execution and ambient light flicker detection.

#### STAT Register (Address 0x71)

Figure 61: STAT Register

| Addr: 0x71 |           | STAT    |        |   |
|------------|-----------|---------|--------|---|
| Bit        | Bit Name  | Default | Access | Bit Description   |
| 7:2        | reserved  | 0       | RW     | reserved  |
| 1          | WAIT_SYNC | 0       | R      | Device waits for sync pulse on GPIO to start integration (SYNS / SYND INT_mode) |
| 0          | READY     | 0       | R      | Spectral measurement status is busy     Spectral measurement status is ready    |



#### STATUS Register (Address 0x93)

The primary status register for AS7341 indicates if there are saturation or interrupt events that need to be handled by the user. This register is self-clearing, meaning that writing a "1" to any bit in the register clears that status bit. In this way, the user should read the STATUS register, handle all indicated event(s) and then write the register value back to STATUS to clear the handled events. Writing "0" will not clear those bits if they have a value of "1", which means that new events that occurred since the last read of the STATUS register will not be accidentally cleared.

Figure 62: STATUS Register

| Addr: 0x93 |          | STATUS  | STATUS |   |  |
|------------|----------|---------|--------|---|--|
| Bit        | Bit Name | Default | Access | Bit Description   |  |
| 7          | ASAT     | 0       | R, SC  | Spectral and Flicker Detect saturation.  If ASIEN is set, indicates Spectral saturation. Check STATUS2 register to distinguish between analog or digital saturation.  |  |
| 6:4        | reserved | 0       | R      | reserved  |  |
|            |          |         |        | Spectral Channel Interrupt.   |  |
| 3          | AINT     | 0       | R, SC  | If SP_IEN is set, indicates that a spectral event that met the programmed thresholds and persistence (APERS) occurred.  |  |
|            |          |         |        | FIFO Buffer Interrupt.  |  |
| 2          | FINT     | 0       | R, SC  | If FIEN is set, indicates that the FIFO_LVL fulfills the threshold condition. If cleared by writing 1, the interrupt will be asserted again as more data is collected. To fully clear this interrupt, all data must be read from the FIFO buffer. |  |
| 1          | C_INT    | 0       | R, SC  | Calibration Interrupt.  |  |
|            |          |         |        | System Interrupt.   |  |
| 0          | SINT     | 0       | R, SC  | If SIEN is set, indicates that system interrupt is set. Refer to Status5 register.  |  |

#### STATUS 2 Register (Address 0xA3)

Figure 63: STATUS 2 Register

| Addr: 0xA3 |          | STATUS 2 | STATUS 2 |  |  |
|------------|----------|----------|----------|--|--|
| Bit        | Bit Name | Default  | Access   | Bit Description  |  |
| 7          | reserved | 0        |          | reserved   |  |
|            |          |          |          | Spectral Valid.  |  |
| 6          | AVALID   | 0        | R        | Indicates that the spectral measurement has been completed |  |
| 5          | reserved | 0        |          | reserved   |  |



| Addr: ( | Addr: 0xA3    |         | STATUS 2 |   |  |
|---------|---------------|---------|----------|---|--|
| Bit     | Bit Name      | Default | Access   | Bit Description   |  |
|         |               |         |          | Digital saturation.   |  |
| 4       | ASAT_DIGITAL  | 0       | R        | Indicates that the maximum counter value has been reached. Maximum counter value depends on integration time set in the ATIME register. |  |
|         |               |         |          | Analog saturation.  |  |
| 3       | ASAT_ANALOG   | 0       | R        | Indicates that the intensity of ambient light has exceeded the maximum integration level for the spectral analog circuit.               |  |
| 2       | reserved      | 0       | R        | reserved  |  |
|         |               |         |          | Flicker detect analog saturation.   |  |
| 1       | FDSAT_ANALOG  | 0       | R        | Indicates that the intensity of ambient light has exceeded the maximum integration level for the analog circuit for flicker detection.  |  |
|         |               |         |          | Flicker detect digital saturation.  |  |
| 0       | FDSAT_DIGITAL | 0       | R        | Indicates that the maximum counter value has been reached during flicker detection.   |  |

# STATUS 3 Register (Address 0xA4)

Figure 64:

**STATUS 3 Register** 

| Addr: 0xA4 |          | STATUS 3 | STATUS 3 |  |
|------------|----------|----------|----------|--|
| Bit        | Bit Name | Default  | Access   | Bit Description  |
| 7:6        | reserved | 0        |          | reserved   |
|            |          |          |          | Spectral interrupt high.   |
| 5          | INT_SP_H | 0        | R        | Indicates that a spectral interrupt occurred because the data exceeded the high threshold. |
|            |          |          |          | Spectral interrupt low.  |
| 4          | INT_SP_L | 0        | R        | Indicates that a spectral interrupt occurred because the data is below the low threshold.  |
| 3:0        | reserved | 0        |          | reserved   |

# STATUS 5 Register (Address 0xA6)

Figure 65:

**STATUS 5 Register** 

| Addr: 0 | xA6      | STATUS 5 |        |                 |
|---------|----------|----------|--------|-----------------|
| Bit     | Bit Name | Default  | Access | Bit Description |
| 7:4     | reserved | 0        |        | reserved        |



| Addr: 0xA6 |           | STATUS 5 | STATUS 5 |  |
|------------|-----------|----------|----------|--|
| Bit        | Bit Name  | Default  | Access   | Bit Description  |
| 3          | SINT_FD   | 0        | R        | Flicker Detect interrupt.  If SIEN_FD is set, indicates that the FD_STATUS register status has changed |
| 2          | SINT_SMUX | 0        | R        | SMUX operation interrupt.  Indicates that SMUX command execution has finished.                         |
| 1:0        | reserved  | 0        |          | reserved   |

# STATUS 6 Register (Address 0xA7)

Figure 66: STATUS 6 Register

| Addr: 0xA7 |            | STATUS 6 | STATUS 6 |  |  |
|------------|------------|----------|----------|--|--|
| Bit        | Bit Name   | Default  | Access   | Bit Description  |  |
| 7          | FIFO_OV    | 0        | R        | FIFO Buffer Overflow. Indicates that the FIFO buffer overflowed and information has been lost. Bit is automatically cleared when the FIFO buffer is read                                 |  |
| 6          | reserved   | 0        | R        | reserved   |  |
| 5          | OVTEMP     | 0        | R        | Over Temperature Detected.  Indicates the device temperature is too high. Write 1 to clear this bit.   |  |
| 4          | FD_TRIG    | 0        | R        | Flicker Detect Trigger Error. Indicates that there is a timing error that prevents flicker detect from working correctly.  |  |
| 3          | reserved   | 0        |          | reserved   |  |
| 2          | SP_TRIG    | 0        | R        | Spectral Trigger Error. Indicates that there is a timing error. The WTIME is too short for the selected ATIME.   |  |
| 1          | SAI_ACTIVE | 0        | R        | Sleep after Interrupt Active. Indicates that the device is in SLEEP due to an interrupt. To exit SLEEP mode, clear this bit.   |  |
| 0          | INT_BUSY   | 0        | R        | Initialization Busy. Indicates that the device is initializing. This bit will remain 1 for about 300µs after power on. Do not interact with the device until initialization is complete. |  |



# FD\_STATUS Register (Address 0xDB)

Figure 67:

**FD STATUS Register** 

| Addr: 0xDB |                            | FD_STATUS |        |   |
|------------|----------------------------|-----------|--------|---|
| Bit        | Bit Name                   | Default   | Access | Bit Description   |
| 7:6        | reserved                   |           |        | reserved  |
|            | FD MEASUREMENT             |           |        | Flicker Detection Measurement Valid.  |
| 5          | VALID                      | 0         | R      | Indicates that flicker detection measurement is complete. Write 1 to this bit to clear this field.  |
|            |                            |           |        | Flicker Saturation Detected.  |
| 4          | FD_SATURATION_<br>DETECTED | 0         | R      | Indicates that saturation occurred during the last flicker detection measurement, and the result may not be valid. Write 1 to this bit to clear this field. |
|            | FD 120HZ FLICKER           |           |        | Flicker Detection 120Hz Flicker Valid.  |
| 3          | VALID                      | 0         | R      | Indicates that the 120Hz flicker detection calculation is valid. Write 1 to this bit to clear this field.   |
|            | FD_100HZ_FLICKER_          | 0         | R      | Flicker Detection 100Hz Flicker Valid.  |
| 2          | VALID                      |           |        | Indicates that the 100Hz flicker detection calculation is valid. Write 1 to this bit to clear this field.   |
|            |                            |           |        | Flicker Detected at 120Hz.  |
| 1          | FD_120HZ_FLICKER           | 0         | R      | Indicates if an ambient light source is flickering at 120Hz.  |
|            |                            |           |        | Flicker Detected at 100Hz.  |
| 0          | FD_100HZ_FLICKER           | 0         | R      | Indicates if an ambient light source is flickering at 100Hz.  |



### 10.2.7 Spectral Data and Status

The ASTATUS register is mapped to register address 0x60 and 0x94. It provides saturation and gain status associated to each set of spectral data. Reading the ASTATUS register (0x60 or 0x94) latches all 12 spectral data bytes to that status read. Reading these bytes consecutively (0x60 to 0x6F or 0x94 to 0xA0) ensures that the data is concurrent. All spectral data are stored as 16-bit values. If flicker detection is enabled, spectral channel five (CH5 ADC) is used for the flicker detection function and CH5\_DATA will read "0". The ASTATUS and spectral data registers are read only.

In SPM or SYNS mode, it is recommended to use the ASTATUS register 0x94 and spectral data register 0x94 to 0xA0. In SYND mode, it is possible to use register 0x60 to 0x6F for easier implementation.

#### ASTATUS Register (Address 0x60 or 0x94)

Figure 68: ASTATUS Register

| Addr: 0x60 and 0x94 |              | ASTATUS |        |  |
|---------------------|--------------|---------|--------|--|
| Bit                 | Bit Name     | Default | Access | Bit Description  |
| 7                   | ASAT_STATUS  | 0       | R, SC  | Saturation Status.  Indicates if the latched data is affected by analog or digital saturation.   |
| 6:4                 | reserved     | 0       | R      | reserved   |
| 3:0                 | AGAIN_STATUS | 0       | R, SC  | Gain Status.  Indicates the gain applied for the spectral data latched to this ASTATUS read. The gain from this status read is required to calculate spectral results if AGC is enabled. |

#### CH0\_DATA Register (Address 0x95/0x96)

Figure 69: CH0\_DATA\_L Register

Addr: 0x95 CH0\_DATA\_L

Bit Bit Name Default Access Bit Description

7:0 CH0\_DATA\_L 0 R CH0 ADC data – low byte



Figure 70:

CH0\_DATA\_H Register

| Addr: ( | )x96       | CH0_DATA_H |        |                          |
|---------|------------|------------|--------|--------------------------|
| Bit     | Bit Name   | Default    | Access | Bit Description          |
| 7:0     | CH0_DATA_H | 0          | R      | CH0 ADC data – high byte |

# CH1\_DATA Register (Address 0x97/0x98)

Figure 71:

CH1\_DATA\_L Register

| Addr: | 0x97 CH1_DATA_L |         | <b>A_L</b> |                         |
|-------|-----------------|---------|------------|-------------------------|
| Bit   | Bit Name        | Default | Access     | Bit Description         |
| 7:0   | CH1_DATA_L      | 0       | R          | CH1 ADC data – low byte |

Figure 72:

CH1\_DATA\_H Register

| Addr: ( | Addr: 0x98 Cl |         | CH1_DATA_H |                          |  |
|---------|---------------|---------|------------|--------------------------|--|
| Bit     | Bit Name      | Default | Access     | Bit Description          |  |
| 7:0     | CH1_DATA_H    | 0       | R          | CH1 ADC data – high byte |  |

### CH2\_DATA Register (Address 0x99/0x9A)

Figure 73:

CH2\_DATA\_L Register

| Addr: | 0x99       | CH2_DATA_L |        |                         |
|-------|------------|------------|--------|-------------------------|
| Bit   | Bit Name   | Default    | Access | Bit Description         |
| 7:0   | CH2_DATA_L | 0          | R      | CH2 ADC data – low byte |



Figure 74:

CH2\_DATA\_H Register

| Addr: ( | Addr: 0x9A |         | CH2_DATA_H |                          |  |
|---------|------------|---------|------------|--------------------------|--|
| Bit     | Bit Name   | Default | Access     | Bit Description          |  |
| 7:0     | CH2_DATA_H | 0       | R          | CH2 ADC data – high byte |  |

# CH3\_DATA Register (Address 0x9B/0x9C)

Figure 75:

CH3\_DATA\_L Register

| Addr: | Addr: 0x9B CF |         | CH3_DATA_L |                         |  |
|-------|---------------|---------|------------|-------------------------|--|
| Bit   | Bit Name      | Default | Access     | Bit Description         |  |
| 7:0   | CH3_DATA_L    | 0       | R          | CH3 ADC data – low byte |  |

Figure 76:

CH3\_DATA\_H Register

| Addr: ( | dr: 0x9C CH3_DATA_H |         | <b>A_H</b> |                          |
|---------|---------------------|---------|------------|--------------------------|
| Bit     | Bit Name            | Default | Access     | Bit Description          |
| 7:0     | CH3_DATA_H          | 0       | R          | CH3 ADC data – high byte |

### CH4\_DATA Register (Address 0x9D/0x9E)

Figure 77:

CH4\_DATA\_L Register

| Addr: 0 | x9D        | CH4_DATA_L |        |                         |
|---------|------------|------------|--------|-------------------------|
| Bit     | Bit Name   | Default    | Access | Bit Description         |
| 7:0     | CH4_DATA_L | 0          | R      | CH4 ADC data – low byte |



Figure 78:

CH4\_DATA\_H Register

| Addr: 0x9E |            | CH4_DATA_H |        |                          |  |
|------------|------------|------------|--------|--------------------------|--|
| Bit        | Bit Name   | Default    | Access | Bit Description          |  |
| 7:0        | CH4_DATA_H | 0          | R      | CH4 ADC data – high byte |  |

# CH5\_DATA Register (Address 0x9F/0xA0)

Figure 79:

CH5\_DATA\_L Register

| Addr: | Addr: 0x9F |         | CH5_DATA_L |                         |  |
|-------|------------|---------|------------|-------------------------|--|
| Bit   | Bit Name   | Default | Access     | Bit Description         |  |
| 7:0   | CH5_DATA_L | 0       | R          | CH5 ADC data – low byte |  |

Figure 80:

CH5\_DATA\_H Register

| Addr: ( | Addr: 0xA0 |         | CH5_DATA_H |                          |  |
|---------|------------|---------|------------|--------------------------|--|
| Bit     | Bit Name   | Default | Access     | Bit Description          |  |
| 7:0     | CH5_DATA_H | 0       | R          | CH5 ADC data – high byte |  |

# 10.2.8 Miscellaneous Configuration

# CFG0 Register (Address 0xA9)

Figure 81:

CFG 0 Register

| Addr: 0xA9 |           | CFG0    |        |  |
|------------|-----------|---------|--------|--|
| Bit        | Bit Name  | Default | Access | Bit Description  |
| 7:6        | reserved  | 0       |        | reserved   |
| 5          | LOW_POWER | 0       | RW     | Low Power Idle.  When asserted, the device will automatically run in a low power mode whenever all functions are in wait states or disabled. |



| Addr: 0xA9 |          | CFG0    | CFG0   |  |  |
|------------|----------|---------|--------|--|--|
| Bit        | Bit Name | Default | Access | Bit Description  |  |
| 4          | REG_BANK | 0       | RW     | Register Bank Access  0: Register access to register 0x80 and above  1: Register access to register 0x60 to 0x74  Note: Bit needs to be set to access registers 0x60 to 0x74. If registers 0x80 and above needs to be accessed bit needs to be set to "0". |  |
| 3          | reserved | 0       |        | reserved   |  |
| 2          | WLONG    | 0       | RW     | Trigger Long. Increases the WTIME setting by a factor of 16.   |  |
| 1:0        | reserved | 0       |        | reserved   |  |

# CFG3 Register (Address 0xAC)

Figure 82: CFG 3 Register

| Addr: 0xAC |          | CFG3    | CFG3   |   |
|------------|----------|---------|--------|---|
| Bit        | Bit Name | Default | Access | Bit Description   |
| 7:5        | reserved | 0       |        | reserved  |
|            |          |         |        | Sleep after interrupt.  |
| 4          | SAI      | 0       | RW     | If set, the oscillator is turned off whenever an interrupt is active. SAI_ACTIVE is set in this event. To activate the oscillator again, clear all interrupts and clear the SAI_ACTIVE bit. |
| 3:0        | reserved | 0xC     |        | reserved  |



# CFG6 Register (Address 0xAF)

Figure 83: CFG 6 Register

| Addr: 0xAF |          | CFG6    | CFG6                           |       |   |  |  |
|------------|----------|---------|--------------------------------|-------|---|--|--|
| Bit        | Bit Name | Default | Default Access Bit Description |       | ption   |  |  |
|            |          |         |                                |       | SMUX command to execute when KEN gets set. Do not change during |  |  |
|            |          |         |                                | VALUE | SMUX_CMD  |  |  |
| 4:3        | SMUX_CMD | 2       | RW                             | 0     | ROM code initialization of SMUX                                 |  |  |
|            |          |         |                                | 1     | Read SMUX configuration to RAM from SMUX chain                  |  |  |
|            |          |         |                                | 2     | Write SMUX configuration from RAM to SMUX chain                 |  |  |
|            |          |         |                                | 3     | Reserved, do not use  |  |  |

# CFG9 Register (Address 0xB2)

Figure 84: CFG 9 Register

| Addr: 0xB2 |           | CFG9    | CFG9   |  |
|------------|-----------|---------|--------|--|
| Bit        | Bit Name  | Default | Access | Bit Description  |
| 7          | reserved  | 0       |        | reserved   |
| 6          | SIEN_FD   | 0       | RW     | System Interrupt Flicker Detection.  Enables system interrupt when flicker detection status change has occurred. |
| 5          | reserved  |         |        | reserved   |
| 4          | SIEN_SMUX | 0       | RW     | System Interrupt SMUX Operation.  Enables system interrupt when SMUX command has finished                        |
| 3:0        | reserved  |         |        | reserved   |



# PERS Register (Address 0xBD)

Figure 85: PERS Register

| Addr: 0xBD |          | PERS    | PERS   |  |  |  |  |
|------------|----------|---------|--------|--|--|--|--|
| Bit        | Bit Name | Default | Access | Bit Des  | cription   |  |  |
| 7:4        | reserved | 0       |        | reserved   |  |  |  |
|            |          |         |        | Spectral   | Interrupt Persistence.   |  |  |
|            |          |         |        | occurrence<br>the thresh<br>SP_TH_H<br>spectral do<br>is set by \$ | filter for the number of consecutive ces that spectral data must remain outside hold range between SP_TH_L and H before an interrupt is generated. The data channel used for the persistence filter SP_TH_CHANNEL. Any sample that is a threshold range resets the counter to 0. |  |  |
|            |          |         |        | VALUE  | CHANNEL  |  |  |
|            |          |         | 514    | 0  | Every spectral cycle generates an interrupt  |  |  |
| 3:0        | APERS    | 0       | RW     | 1  | 1  |  |  |
|            |          |         |        | 2  | 2  |  |  |
|            |          |         |        | 3  | 3  |  |  |
|            |          |         |        | 4  | 5  |  |  |
|            |          |         |        | 5  | 10   |  |  |
|            |          |         |        |  | 5 x (APERS – 3)  |  |  |
|            |          |         |        | 14   | 55   |  |  |
|            |          |         |        | 15   | 60   |  |  |



#### 10.2.9 FIFO Buffer Data and Status

The FIFO buffer is used to poll spectral data with fewer I²C read and write transactions. The FIFO buffer is 256 bytes of RAM containing 128 two-byte datasets. If the FIFO overflows (i.e. 129 datasets before host reads data from the FIFO buffer), an overflow flag will be set and new data will be lost. The Host acquires data by reading addresses: 0xFE - 0xFF. The register address pointer automatically wraps from 0xFF to 0xFE as data are read. Data can be read one byte at a time or in blocks, (there is no block-read length limit). When reading single bytes, the internal FIFO read pointer and the FIFO Buffer Level, FIFO\_LVL, are updated each time register 0xFF is read. For block-reads, the internal FIFO read pointer and the FIFO Buffer Level, FIFO\_LVL update for each two-byte entry. If the FIFO continues to be accessed after FIFO\_LVL = 0, the device will return 0 for all data. The FINT interrupt indicates when there is valid data in the FIFO buffer. The amount of unread data is indicated by the FIFO\_LVL.

#### FIFO\_MAP Register (Address 0xFC)

Figure 86: FIFO\_MAP Register

| Addr: | Addr: 0xFC          |         | FIFO_MAP |  |
|-------|---------------------|---------|----------|--|
| Bit   | Bit Name            | Default | Access   | Bit Description  |
| 7     | reserved            | 0       |          | reserved   |
| 6     | FIFO_WRITE_CH5_DATA | 0       | RW       | FIFO write CH5 Data.  If set, CH5 data is written to the FIFO Buffer. (two bytes per sample)  Note: If flicker detection is enabled, this bit is |
|       |                     |         |          | ignored. Refer to register 0xD7 for FDEN="1".  |
| 5     | FIFO_WRITE_CH4_DATA | 0       | RW       | FIFO write CH4 Data.  If set, CH4 data is written to the FIFO Buffer. (two bytes per sample)   |
|       |                     |         |          | FIFO write CH3 Data.   |
| 4     | FIFO_WRITE_CH3_DATA | 0       | RW       | If set, CH3 data is written to the FIFO Buffer. (two bytes per sample)   |
|       |                     |         |          | FIFO write CH2 Data.   |
| 3     | FIFO_WRITE_CH2_DATA | 0       | RW       | If set, CH2 data is written to the FIFO Buffer. (two bytes per sample)   |
|       |                     |         |          | FIFO write CH1 Data.   |
| 2     | FIFO_WRITE_CH1_DATA | 0       | RW       | If set, CH1 data is written to the FIFO Buffer. (two bytes per sample)   |
|       |                     |         |          | FIFO write CH0 Data.   |
| 1     | FIFO_WRITE_CH0_DATA | 0       | RW       | If set, CH0 data is written to the FIFO Buffer. (two bytes per sample)   |
|       |                     |         |          | FIFO write Status.   |
| 0     | FIFO_WRITE_ASTATUS  | 0       | RW       | If set, ASTATUS (one byte per sample) is written to the FIFO Buffer.   |
|       |                     |         |          | In case SP_AGC_ENABLE = 1, ASTATUS should be written to FIFO buffer.   |



#### FIFO\_CFG0 Register (Address 0xD7)

Figure 87:

FIFO\_CFG0 Register

| Addr: 0xD7 |               | FIFO_CFG | FIFO_CFG0 |  |
|------------|---------------|----------|-----------|--|
| Bit        | Bit Name      | Default  | Access    | Bit Description  |
|            |               |          |           | FIFO write Flicker Detection   |
| 7          | FIFO_WRITE_FD | 0        | R/W       | If set flicker raw data is written into FIFO (two bytes per sample)                              |
|            |               |          |           | Note: This bit is ignored if flicker detection is disabled. Refer to register 0xFC for FDEN="0". |
| 6:0        | reserved      | 0100001  |           | Reserved, do not change  |

# FIFO\_LVL Register (Address 0xFD)

Figure 88:

FIFO\_LVL Register

| Addr: 0xFD FI |          | FIFO_LVL | FIFO_LVL |   |  |
|---------------|----------|----------|----------|---|--|
| Bit           | Bit Name | Default  | Access   | Bit Description   |  |
| 7:0           | FIFO_LVL | 0        | R        | FIFO Buffer Level. Indicates the number of entries (each are 2 bytes) available in the FIFO buffer waiting for readout. The FIFO RAM is 256byte, the FIFO_LVL range is from 0 entries to 128 entries. |  |

# FDATA Register (Address 0xFE and 0xFF)

Figure 89:

**FDATA** Register

| Addr: 0 | )xFE     | FDATA   |        |                  |
|---------|----------|---------|--------|------------------|
| Bit     | Bit Name | Default | Access | Bit Description  |
| 7:0     | FDATA    | 0       | R      | FIFO Buffer Data |



# Figure 90: FDATA Register

| Addr: | 0xFF     | FDATA   |        |                  |
|-------|----------|---------|--------|------------------|
| Bit   | Bit Name | Default | Access | Bit Description  |
| 15:8  | FDATA    | 0       | R      | FIFO Buffer Data |

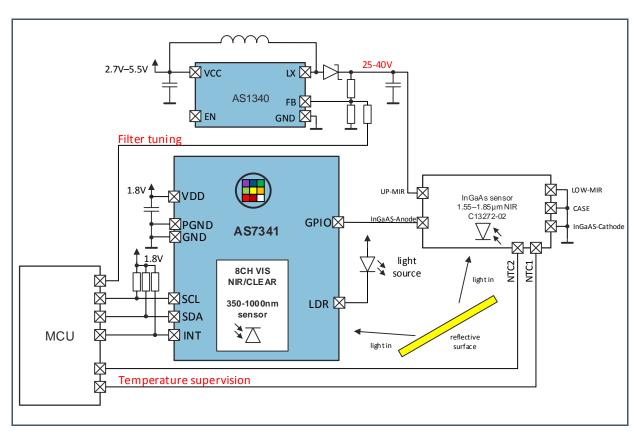


# 11 Application Information

Figure 91 shows an example how AS7341 can be utilized to interface to an external InGaAs photodiode. GPIO2 is mapped to an internal ADC.

# 11.1 Schematic

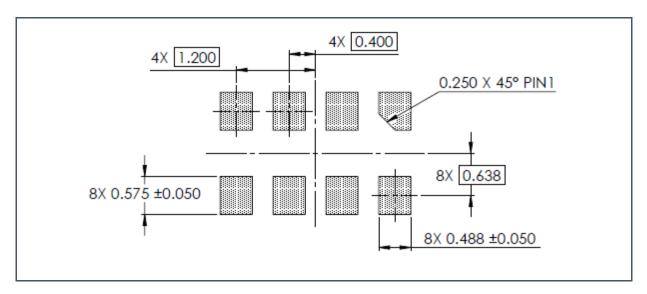
Figure 91:
Application Example with External InGaAs Detector





# 11.2 PCB Pad Layout

Figure 92: Recommended PCB Pad Layout



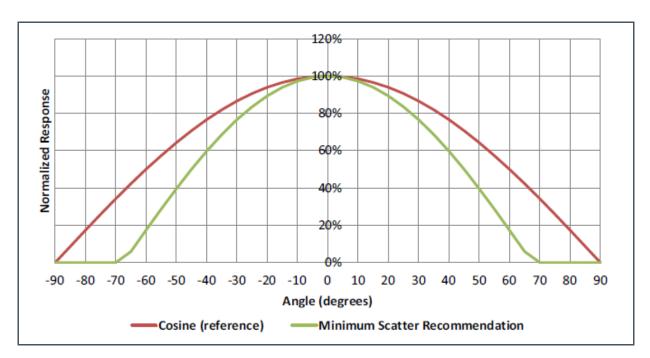
- (1) All dimensions are in millimeters.
- (2) Dimension tolerances are 0.05mm unless otherwise noted.
- (3) This drawing is subject to change without notice.



# 11.3 Application Optical Requirements

For optimal performance, an achromatic diffuser shall be placed above the device aperture. The recommended solution is a bulk diffuser that meets the minimum recommended scattering characteristic shown below. For more details refer to the optical design guide or contact ams.

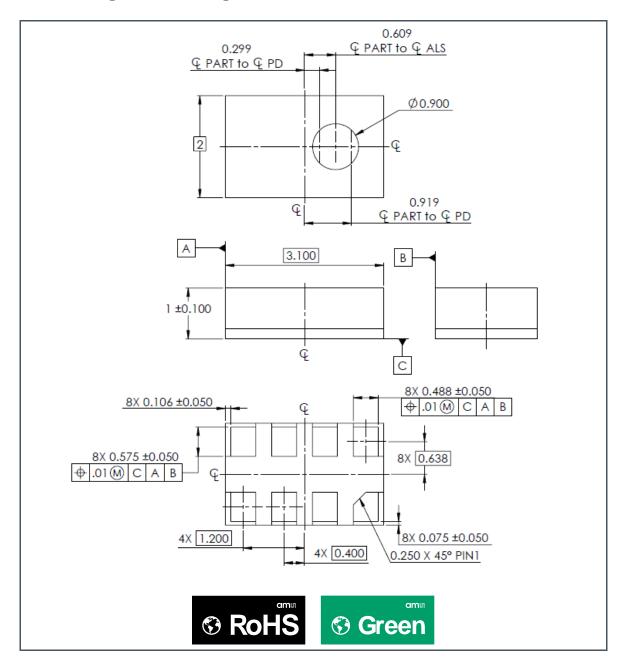
Figure 93: Diffuser Characteristics





# 12 Package Drawings & Markings

Figure 94: OLGA8 Package Outline Drawing

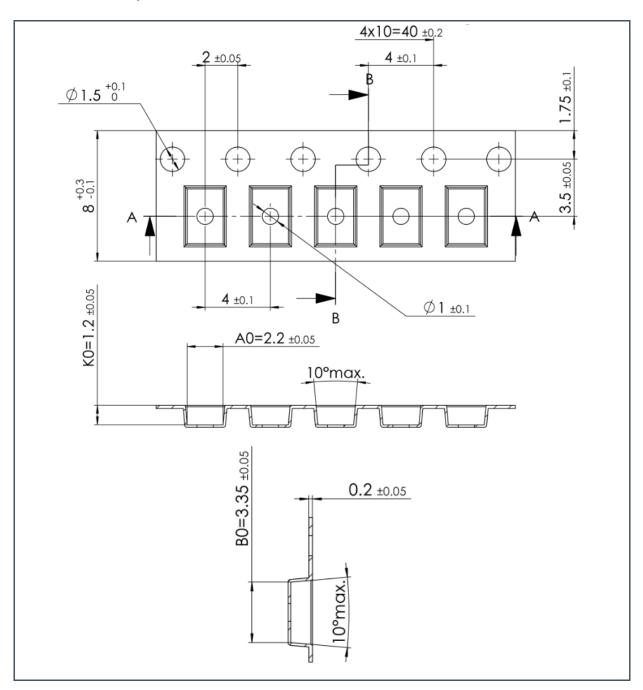


- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Dimensioning and tolerance conform to ASME Y14.5M-1994.
- (3) This package contains no lead (Pb).
- (4) This drawing is subject to change without notice.



# 13 Tape & Reel Information

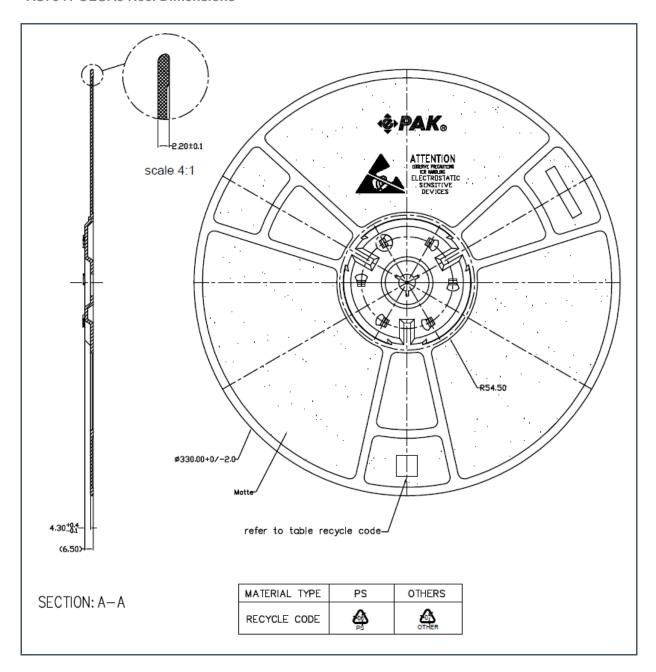
Figure 95: AS7341 OLGA8 Tape Dimensions



- (1) All dimensions are in millimeters. Angles in degrees.
- (2) This drawing is subject to change without notice.



Figure 96: AS7341 OLGA8 Reel Dimensions



- (1) All dimensions are in millimeters. Angles in degrees.
- (2) This drawing is subject to change without notice.



# 14 Soldering & Storage Information

Figure 97: Solder Reflow Profile Graph

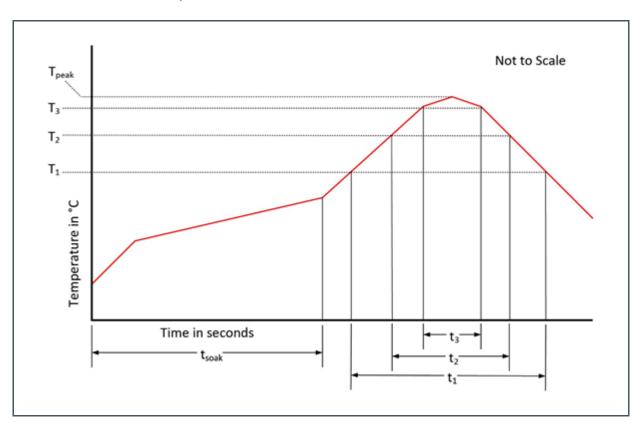


Figure 98: Solder Reflow Profile

| Parameter                                  | Reference         | Device         |
|--|-------------------|----------------|
| Average temperature gradient in preheating |                   | 2.5 °C/s       |
| Soak time                                  | t <sub>soak</sub> | 2 to 3 minutes |
| Time above 217 °C (T1)                     | t <sub>1</sub>    | Max 60 s       |
| Time above 230 °C (T2)                     | t <sub>2</sub>    | Max 50 s       |
| Time above T <sub>peak</sub> – 10 °C (T3)  | t <sub>3</sub>    | Max 10 s       |
| Peak temperature in reflow                 | T <sub>peak</sub> | 260 °C         |
| Temperature gradient in cooling            |                   | Max -5 °C/s    |



# 14.1 Storage Information

#### 14.1.1 Moisture Sensitivity

Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package.

To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping. Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

#### 14.1.2 Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 12 months from the date code on the bag when stored under the following conditions:

Shelf Life: 12 months

Ambient Temperature: <40°C</p>

Relative Humidity: <90%</li>

Rebaking of the devices will be required if the devices exceed the 12 month shelf life or the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

#### 14.1.3 Floor Life

The module has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

Floor Life: 168 hours

Ambient Temperature: <30°C</li>

Relative Humidity: <60%</li>

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

#### 14.1.4 Rebaking Instructions

When the shelf life or floor life limits have been exceeded, rebake at 50°C for 12 hours.



# 15 Revision Information

| Document Status             | Product Status  | Definition   |
|-----------------------------|-----------------|--|
| Product Preview             | Pre-Development | Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice  |
| Preliminary Datasheet       | Pre-Production  | Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice            |
| Datasheet                   | Production      | Information in this datasheet is based on products in ramp-up to full production or full production which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade                                |
| Datasheet<br>(discontinued) | Discontinued    | Information in this datasheet is based on products which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade, but these products have been superseded and should not be used for new designs |

| Changes from previous version to current revision v2-00 | Page |
|---|------|
| -updated center wavelength and FWHM of F1 to F8         | 9-12 |

- Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- Correction of typographical errors is not explicitly mentioned.



# 16 Legal Information

#### Copyrights & Disclaimer

Copyright ams AG, Tobelbader Strasse 30, 8141 Premstaetten, Austria-Europe. Trademarks Registered. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

Devices sold by ams AG are covered by the warranty and patent indemnification provisions appearing in its General Terms of Trade. ams AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein. ams AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with ams AG for current information. This product is intended for use in commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by ams AG for each application. This product is provided by ams AG "AS IS" and any express or implied warranties, including, but not limited to the implied warranties of merchantability and fitness for a particular purpose are disclaimed.

ams AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of ams AG rendering of technical or other services.

#### **RoHS Compliant & ams Green Statement**

**RoHS Compliant:** The term RoHS compliant means that ams AG products fully comply with current RoHS directives. Our semiconductor products do not contain any chemicals for all 6 substance categories, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, RoHS compliant products are suitable for use in specified lead-free processes.

ams Green (RoHS compliant and no Sb/Br): ams Green defines that in addition to RoHS compliance, our products are free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material).

**Important Information:** The information provided in this statement represents ams AG knowledge and belief as of the date that it is provided. ams AG bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. ams AG has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. ams AG and ams AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

#### Headquarters

ams AG

Tobelbader Strasse 30 8141 Premstaetten Austria, Europe

Tel: +43 (0) 3136 500 0

Please visit our website at www.ams.com

Buy our products or get free samples online at www.ams.com/Products

Technical Support is available at www.ams.com/Technical-Support

Provide feedback about this document at www.ams.com/Document-Feedback

For sales offices, distributors and representatives go to www.ams.com/Contact

For further information and requests, e-mail us at ams\_sales@ams.com